

# 8-bit Proprietary Microcontrollers

CMOS

## F<sup>2</sup>MC-8L MB89580B/580BW Series

### MB89583B/585B/589B/P585B/P589B/ MB89583BW/585BW/P585BW

#### ■ DESCRIPTION

The MB89580B/BW series is a line of general-purpose, single-chip microcontrollers. In addition to a compact instruction set, these microcontrollers contain a variety of peripheral functions, such as PLL clock control, timers, a serial interface, a PWM timer, and the USB function. In particular, these microcontrollers contain one USB function channel to support both high and low speeds.

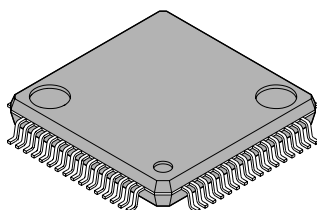
#### ■ FEATURES

- **Package type**  
64-pin LQFP package (0.5 mm pitch) and 64-pin QFP package (0.65 mm pitch)
- **High-speed operations at low voltage**  
Minimum execution time : 0.33  $\mu$ s (Automatically generates a 12 MHz main clock and a 48 MHz USB interface synchronization clock with an externally supplied 6 MHz clock and the internal PLL circuit.)
- **F<sup>2</sup>MC-8L CPU core**  
Instruction set that is optimum to the controllers
  - Multiplication and division instructions
  - 16-bit arithmetic operations
  - branch instructions by bit testing
  - bit manipulation instructions, etc.

(Continued)

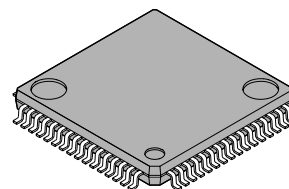
#### ■ PACKAGE

64-pin plastic LQFP



(FPT-64P-M03)

64-pin plastic QFP



(FPT-64P-M09)

# MB89580B/580BW series

(Continued)

- **PLL clock control**

The internal PLL clock circuit allows the use of low-speed clocks which are advantageous to noise characteristics.

(6 MHz externally-supplied clock : Internal system clock oscillated at 12 MHz)

- **Various timers**

8-bit PWM timer (can be used as either 8-bit PWM timer × 2 channels or PPG timer × 1 channel)

Internal 21-bit timebase timer

- **Internal USB transceiver circuit (Compatible with high and low speeds)**

- **USB function**

Compliant to USB Protocol Revision 1.0

Support for both low and full speeds (selectable)

Allows four endpoints to be specified at maximum.

Types of transfer supported : control/interrupt/bulk/isochronous

Built-in DMAC (Maps the buffer for each endpoint on to the internal RAM to directly access the memory for function's send and receive data.)

- **UART/serial interface**

Built-in UART/SIO function (selectable by switching)

- **External interrupt**

External interrupt (level detection × 8 channels)

Eight inputs are independent of one another and can also be used for resetting from low-power consumption mode (the L-level detection feature available) .

- **Low power consumption (standby mode supported)**

Stop mode (There is almost no current consumption since oscillation stops.)

Sleep mode (This mode stops the running CPU.)

- **A maximum of 53 general-purpose I/O ports**

General-purpose I/O ports (CMOS) : 34

General-purpose output ports (CMOS) : 8

General-purpose I/O ports (Nch open drain) : 3

General-purpose input ports (CMOS 3.3 V input-compatible) : 8

- **Parallel ports**

Also serve as eight of the general-purpose I/O ports (CMOS)

Interrupt function available

Allows asynchronous read and write by external signals

- **Power supply**

Supply voltage : 3.0 to 5.5 V

# MB89580B/580BW series

## ■ PRODUCT LINEUP

Part number		MB89583B	MB89585B	MB89P585B	MB89589B	MB89P589B	MB89583BW	MB89585BW	MB89P585BW		
Parameter											
ROM size		8 KB	16 KB				8 KB	16 KB			
RAM size		512 B	1 KB		18 KB		512 B	1 KB			
Package		LQFP-64 (FPT-64P-M03)			QFP-64 (FPT-64P-M09)		LQFP-64 (FPT-64P-M03)				
Operation at USB reset		High impedance state					Low-level output				
Others		MASK product		OTP/EVA product	MASK product	OTP/EVA product	MASK product		OTP/EVA product		
CPU functions		Number of instructions : 136 Instruction bit length : 8 bits Instruction length : 1 to 3 bytes Data bit length : 1, 8, and 16 bits Minimum execution time : 0.33 μs (6 MHz) Interrupt processing time : 3 μs (6 MHz)									
Peripheral functions	General-purpose ports	General-purpose I/O ports (34 : CMOS, 3 : Nch open drain) General-purpose output ports (8 : CMOS) General-purpose input ports (8 : CMOS 3.3 V input)									
	Parallel ports	Shares eight (P40 through P47) of the above general-purpose I/O ports. Allows asynchronous read and write by external signals. An interrupt function is available to set data.									
	USB function	Can be set to full/low speed. Four endpoints at maximum Power supply mode : Can be set to own power supply/bus power supply mode. FIFO 8 bits × 8 built in Built-in DMAC (Can be set to DMA transfer to the internal RAM or to the external FIFO.)									
	PWM timer	8-bit PWM timer operation × 2 channels (can also be used as a PPG × 1 channel timer)									
	UART	SIO	Allows switching between UART (clock-synchronous/asynchronous data transfer allowed) and SIO (simple serial transfer) .								
	Timebase timer	21-bit timebase timer									
	Clock output	Allows output of two main clock divisions									
Standby mode		Sleep mode and Stop mode									

## ■ PACKAGES AND CORRESPONDING PRODUCTS

Package	MB89583B	MB89585B	MB89P585B	MB89589B	MB89P589B	MB89583BW	MB89585BW	MB89P585BW
FPT-64P-M03	○	○	○	×	×	○	○	○
FPT-64P-M09	×	×	×	○	○	×	×	×

○ : Available    × : Not available

# MB89580B/580BW series

## ■ DIFFERENCES AMONG PRODUCTS

### 1. Memory Size

Before evaluating using the OTP product, verify its differences from the product that will actually be used.

### 2. Current Consumption

When operated at low speeds, a product mounted with either one-time PROM or EPROM consumes more current than a product mounted with a mask ROM. However, in sleep/stop mode the current consumption is the same.

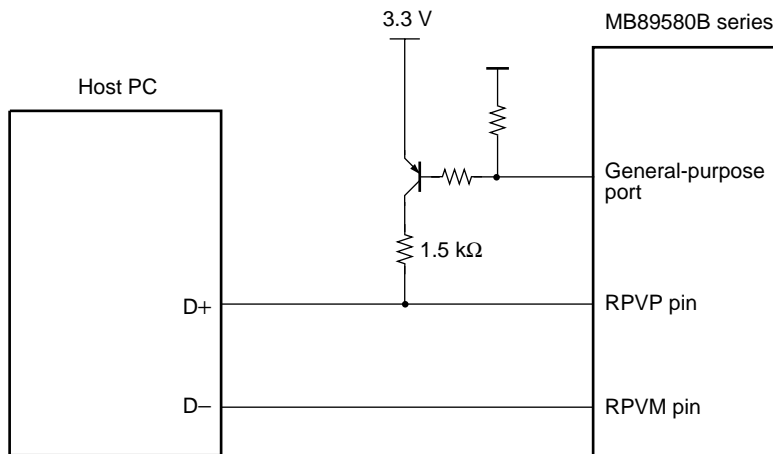
For detailed information on each package, see “■ PACKAGE DIMENSIONS.”

### 3. Differences Between the MB89580B series and the MB89580BW Series

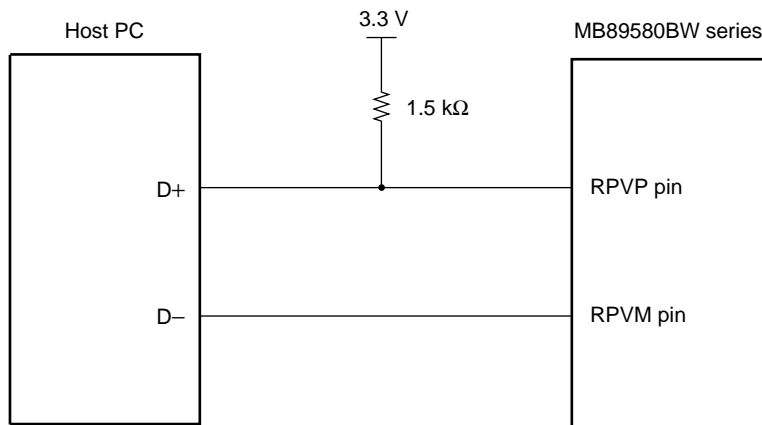
MB89580B series : Remains in high impedance state until USB connection takes place. Before the USB connection, use one general-purpose port output to control pullup resistance connection of this port by software.

MB89580BW : Outputs at low level until USB connection takes place.

#### • Example MB89580B product connection



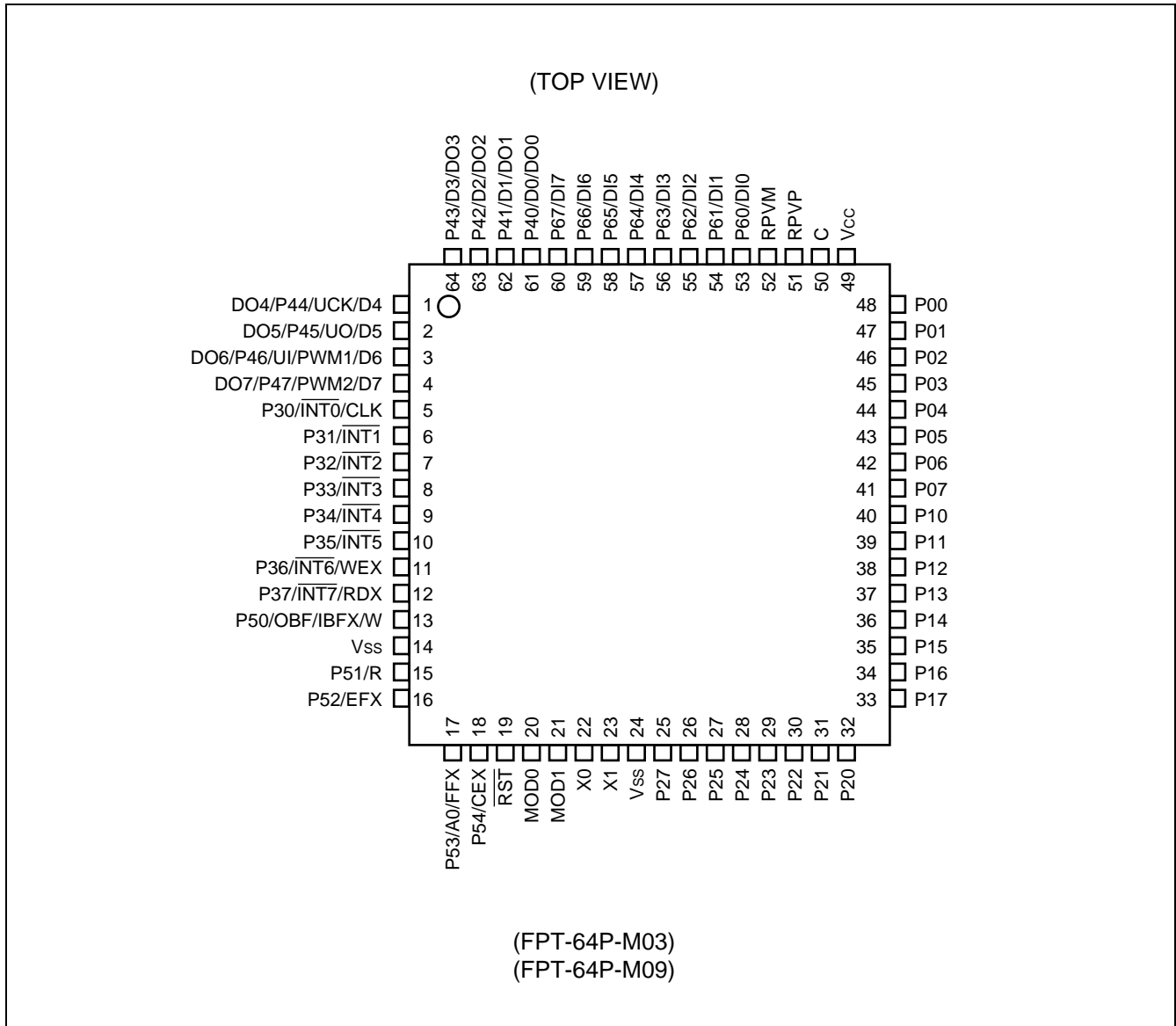
#### • Example MB89580BW product connection



Note : Full speed is assumed in the above examples.

# MB89580B/580BW series

## PIN ASSIGNMENT



# MB89580B/580BW series

## ■ PIN DESCRIPTION

Pin No.	Pin name	Circuit type	Function
1	P44/U $\overline{C}$ K/D4/DO4	E	General-purpose CMOS I/O pin UART/S10 clock I/O This pin also serves as a parallel interface/external FIFO data output pin.
2	P45/UO/D5/DO5	B	General-purpose CMOS I/O pin UART/S10 serial data output This pin also serves as a parallel interface/external FIFO data output pin.
3	P46/UI/PWM1/D6/DO6	E	General-purpose CMOS I/O pin UART/S10 serial data input PWM timer This pin also serves as a parallel interface/external FIFO data output pin.
4	P47/PWM2/D7/DO7	B	General-purpose CMOS I/O pin PWM timer This pin also serves as a parallel interface/external FIFO data output pin.
5	P30/ $\overline{INT0}$ /CLK	E	General-purpose CMOS I/O pin Clock output pin This pin also serves as an external interrupt input pin. The external interrupt input is a hysteresis input. (Level detection)
6	P31/ $\overline{INT1}$	E	General-purpose CMOS I/O pin This pin also serves as an external interrupt input pin. The external interrupt input is a hysteresis input. (Level detection)
7	P32/ $\overline{INT2}$	E	General-purpose CMOS I/O pin This pin also serves as an external interrupt input pin. The external interrupt input is a hysteresis input. (Level detection)
8	P33/ $\overline{INT3}$	E	General-purpose CMOS I/O pin This pin also serves as an external interrupt input pin. The external interrupt input is a hysteresis input. (Level detection)
9	P34/ $\overline{INT4}$	E	General-purpose CMOS I/O pin This pin also serves as an external interrupt input pin. The external interrupt input is a hysteresis input. (Level detection)
10	P35/ $\overline{INT5}$	E	General-purpose CMOS I/O pin This pin also serves as an external interrupt input pin. The external interrupt input is a hysteresis input. (Level detection)
11	P36/ $\overline{INT6}$ /WEX	E	General-purpose CMOS I/O pin This pin also serves as an external interrupt input pin. The external interrupt input is a hysteresis input. (Level detection) This pin also serves as the parallel interface write strobe input pin.
12	P37/ $\overline{INT7}$ /RDX	E	General-purpose CMOS I/O pin This pin also serves as an external interrupt input pin. The external interrupt input is a hysteresis input. (Level detection) This pin also serves as the parallel interface read strobe input pin.
13	P50/OBF/IBFX/W	B	General-purpose CMOS I/O pin Interrupt output to the parallel interface host. This pin also serves the OUT FIFO data strobe pin.

(Continued)

# MB89580B/580BW series

Pin No.	Pin name	Circuit type	Function
14	V <sub>SS</sub>	—	Power supply pin (GND)
15	P51/R	B	General-purpose CMOS I/O pin. This pin also serves the IN FIFO data strobe pin.
16	P52/EFX	K	General-purpose Nch open drain I/O pin. This pin also serves as the IN FIFO data enable input pin.
17	P53/A0/FFX	K	General-purpose Nch open drain I/O pin. Parallel interface's data select input This pin also serves as the OUT FIFO data enable input pin.
18	P54/CEX	K	General-purpose Nch open drain I/O pin. This pin also serves as the parallel interface device select input pin.
19	$\overline{\text{RST}}$	I	Reset pin. (Reset on the negative logic low level.)
20	MOD0	F	An operating mode designation pin. Connect directly to V <sub>SS</sub> .
21	MOD1	F	An operating mode designation pin. Connect directly to V <sub>SS</sub> .
22	X0	A	Pins for the crystal oscillator (6 MHz)
23	X1		
24	V <sub>SS</sub>	—	Power supply pin (GND)
25	P27	B	General-purpose CMOS output pin
26	P26	B	General-purpose CMOS output pin
27	P25	B	General-purpose CMOS output pin
28	P24	B	General-purpose CMOS output pin
29	P23	B	General-purpose CMOS output pin
30	P22	B	General-purpose CMOS output pin
31	P21	B	General-purpose CMOS output pin
32	P20	B	General-purpose CMOS output pin
33	P17	B	General-purpose CMOS I/O pin
34	P16	B	General-purpose CMOS I/O pin
35	P15	B	General-purpose CMOS I/O pin
36	P14	B	General-purpose CMOS I/O pin
37	P13	B	General-purpose CMOS I/O pin
38	P12	B	General-purpose CMOS I/O pin
39	P11	B	General-purpose CMOS I/O pin
40	P10	B	General-purpose CMOS I/O pin
41	P07	B	General-purpose CMOS I/O pin
42	P06	B	General-purpose CMOS I/O pin
43	P05	B	General-purpose CMOS I/O pin
44	P04	B	General-purpose CMOS I/O pin

(Continued)

# MB89580B/580BW series

(Continued)

Pin No.	Pin name	Circuit type	Function
45	P03	B	General-purpose CMOS I/O pin
46	P02	B	General-purpose CMOS I/O pin
47	P01	B	General-purpose CMOS I/O pin
48	P00	B	General-purpose CMOS I/O pin
49	V <sub>cc</sub>	—	Power supply pin
50	C	—	Connect an external capacitor of 0.1 $\mu$ F. When using with 3.3 V power supply, connect this pin with the V <sub>cc</sub> pin to set to 3.3 V input.
51	RPVP	USBDRV	USB route port + pin
52	RPVM	USBDRV	USB router port – pin
53	P60/DI0	F	General-purpose CMOS input pin (3.3 V input) This pin also serves as an external FIFO data input pin. (LSB)
54	P61/DI1	F	General-purpose CMOS input pin (3.3 V input) This pin also serves as an external FIFO data input pin.
55	P62/DI2	F	General-purpose CMOS input pin (3.3 V input) This pin also serves as an external FIFO data input pin.
56	P63/DI3	F	General-purpose CMOS input pin (3.3 V input) This pin also serves as an external FIFO data input pin.
57	P64/DI4	F	General-purpose CMOS input pin (3.3 V input) This pin also serves as an external FIFO data input pin.
58	P65/DI5	F	General-purpose CMOS input pin (3.3 V input) This pin also serves as an external FIFO data input pin.
59	P66/DI6	F	General-purpose CMOS input pin (3.3 V input) This pin also serves as an external FIFO data input pin.
60	P67/DI7	F	General-purpose CMOS input pin (3.3 V input) This pin also serves as an external FIFO data input pin. (MSB)
61	P40/D0/DO0	B	General-purpose CMOS I/O pin This pin serves as a parallel interface/external FIFO data output pin.
62	P41/D1/DO1	B	General-purpose CMOS I/O pin This pin serves as a parallel interface/external FIFO data output pin.
63	P42/D2/DO2	B	General-purpose CMOS I/O pin This pin serves as a parallel interface/external FIFO data output pin.
64	P43/D3/DO3	B	General-purpose CMOS I/O pin This pin serves as a parallel interface/external FIFO data output pin.



# MB89580B/580BW series

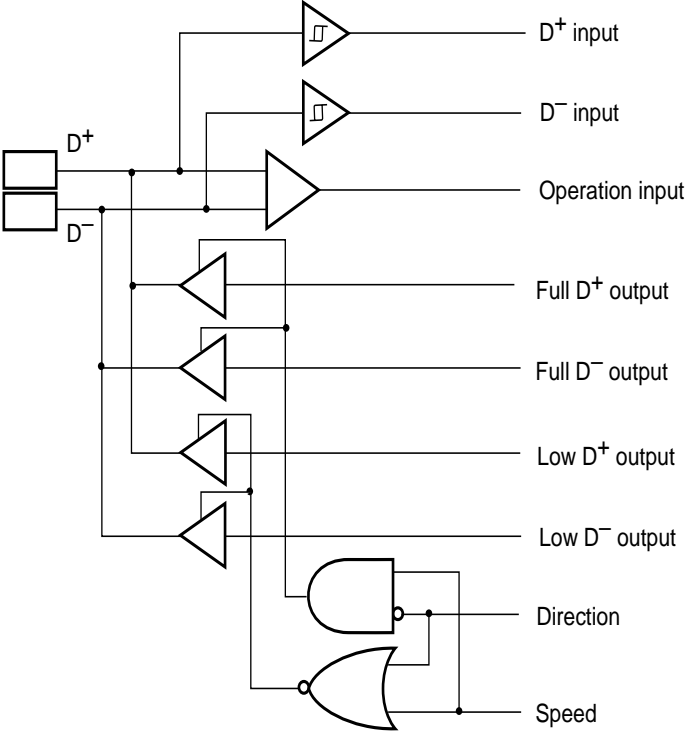
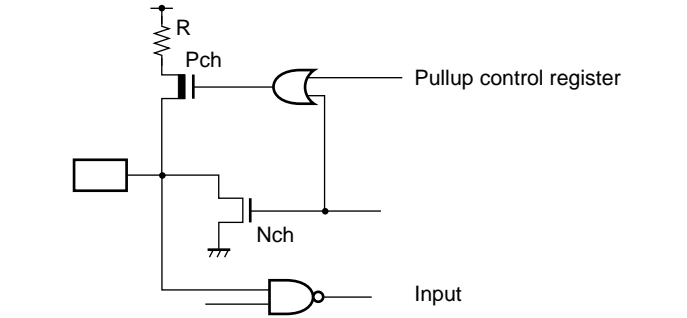
## ■ I/O CIRCUIT TYPE

Type	Circuit	Remarks
A		Oscillation feedback resistance Approx. 1 MΩ
B		CMOS I/O
E		CMOS I/O Hysteresis input
F		CMOS input
I		Hysteresis I/O Pullup resistance

(Continued)

# MB89580B/580BW series

(Continued)

Type	Circuit	Remarks
USBDRV	 <p>The circuit diagram for USBDRV shows two input pins, D+ and D-. The D+ line is connected to a buffer and an inverter. The D- line is connected to a buffer and an inverter. The outputs are labeled: D+ input, D- input, Operation input, Full D+ output, Full D- output, Low D+ output, and Low D- output. The circuit also includes a Direction control input (AND gate) and a Speed control input (OR gate).</p>	USB I/O
K	 <p>The circuit diagram for K type shows an input pin connected to a pullup resistor R and a pullup control register Pch. The input is also connected to an Nch (N-channel MOSFET) and an Input control register. The Nch is connected to ground.</p>	Nch open drain I/O

## ■ HANDLING DEVICES

### 1. Preventing Latchup

Latchup may occur on CMOS ICs if voltage higher than  $V_{cc}$  or lower than  $V_{ss}$  is applied to input or output pins other than the medium- and high-voltage pins or if voltage higher than the rating is applied between  $V_{cc}$  and  $V_{ss}$ .

When latchup occurs, power supply current increases rapidly and might thermally damage elements. When using, take great care not to exceed the absolute maximum ratings.

Also take care to prevent the analog input from exceeding the digital power supply ( $V_{cc}$ ) when the power supply to the analog power system is turned on and off.

### 2. Treatment of Unused Input Pins

Leaving unused input pins open could cause malfunctions and latchup leading to permanent damage to the pins. These unused pins should be connected to a pullup or pulldown resistance of at least  $2\text{ k}\Omega$  between the pin and the power supply.

Unused I/O pins should be placed in output state to leave it open or pins that are in input state should be handled the same as unused input pins.

### 3. Power Supply Voltage Fluctuations

Although  $V_{cc}$  power supply voltage is assured to operate within the rated range, a rapid fluctuation of the voltage could cause malfunctions even if it occurs within the rated range. Stabilizing voltage supplied to the IC is therefore important. As stabilization guidelines, it is recommended to control power so that  $V_{cc}$  ripple fluctuations (P-P value) will be less than 10% of the standard  $V_{cc}$  value at the commercial frequency (50 to 60 Hz) and the transient fluctuation rate will be less than  $0.1\text{ V/ms}$  at the time of a momentary fluctuation such as when power is switched.

# MB89580B/580BW series

## ■ ONE-TIME PROM AND EPROM MICROCONTROLLER PROGRAMMING SPECIFICATIONS

PROM mode is available on the MB89P585B/BW microcontrollers. The use of a dedicated adapter allows you to program the devices with a general-purpose ROM programmer. However, keep in mind that electronic signature mode is not available.

### 1. ROM programmer adapter and its compatible programmers

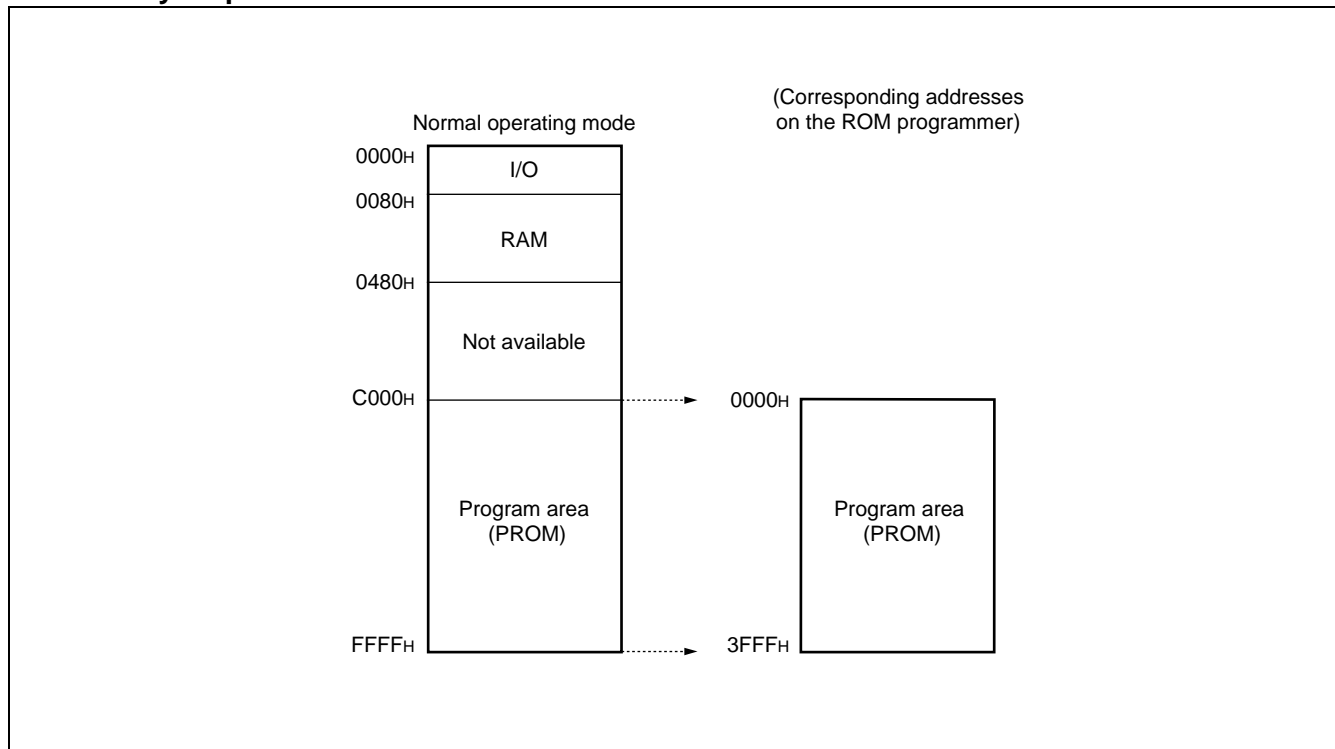
Package	Compatible adapter	Compatible programmers and models
	Sun Hayato Co, Ltd.	Ando Denki K. K.
FTP-64P-M03	ROM2-64LQF-32DP-8LA	AF9708 (Version 1.40 or higher) AF9709 (Version 1.40 or higher) AF9723 (Version 1.50 or higher)

Inquiry:

Sun Hayato Co., Ltd. : TEL. 81-3-3986-0403

Ando Denki K. K. : TEL. 81-3-3733-1160

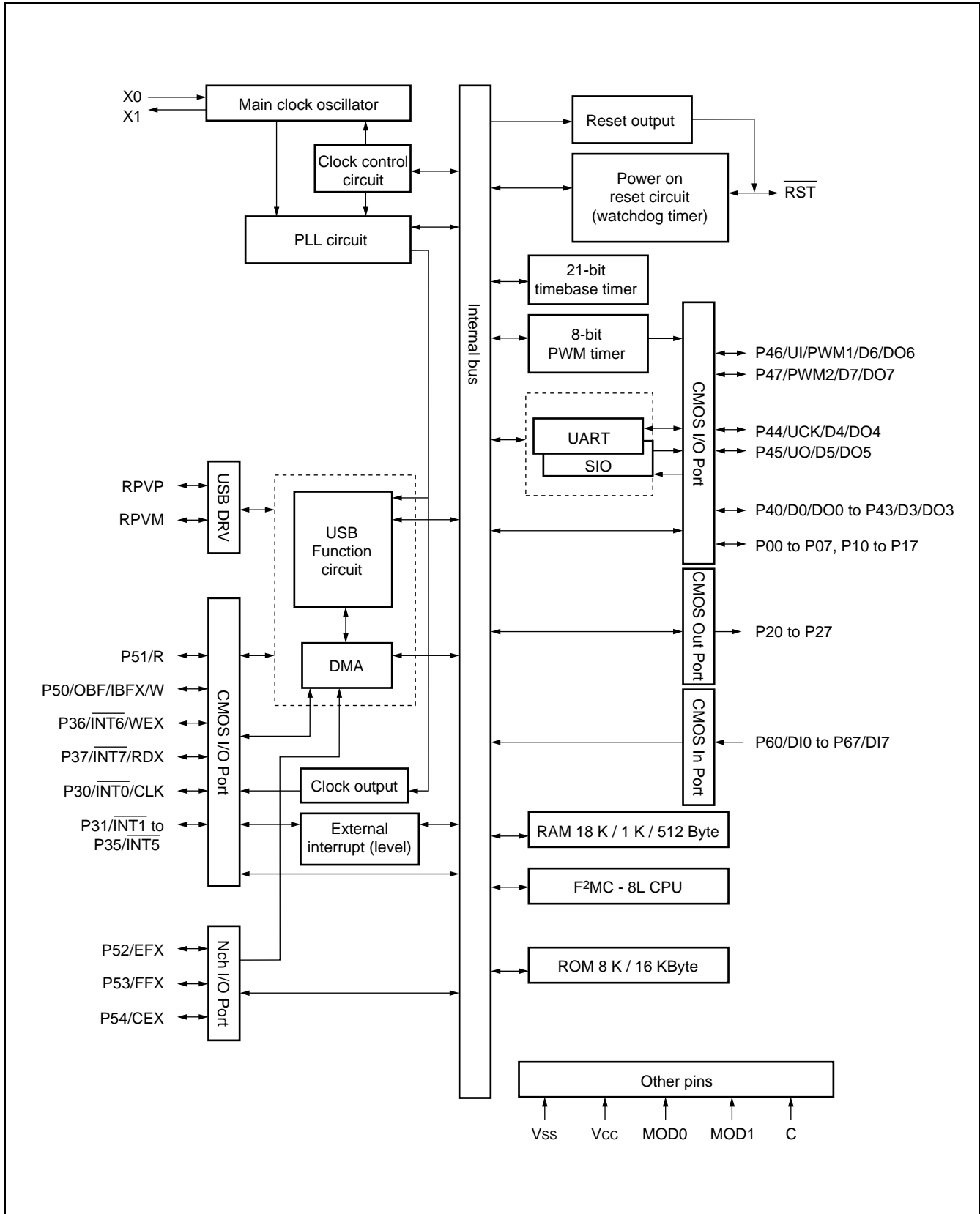
### 2. Memory map in PROM mode



### 3. Programming the EPROM (Using the Ando Denki K.K. programmer)

- (1) Set the EPROM programmer type code to 17209.
- (2) Load program data on to the EPROM programmer at 0000H to 3FFFH.
- (3) Program C000H to FFFFH with the EPROM programmer.

## ■ BLOCK DIAGRAM



# MB89580B/580BW series

## ■ CPU CORE

### 1. Memory Space

The MB89580B/BW microcontrollers offer a memory space of 64 Kbytes consisting of the I/O, RAM and ROM areas. The memory space contains areas that are used for specific purposes, such as a general-purpose register and a vector table.

- I/O area (addresses : 0000H through 007FH)

This area is assigned with the control and data registers, for example, of peripheral functions to be built in. The I/O area is as accessible as the memory since the area is assigned to a part of the memory space. Direct addressing also allows the area to be accessed faster.

- RAM area

As an internal data area, a static RAM is built in.

The internal RAM capacity varies with the product type.

The area 80H to FFH can be accessed at high speed with direct addressing.

The area 100H to 1FFH can be used a general-purpose register area. (The usable area is limited depending on the product.)

When reset, RAM data becomes undefined.

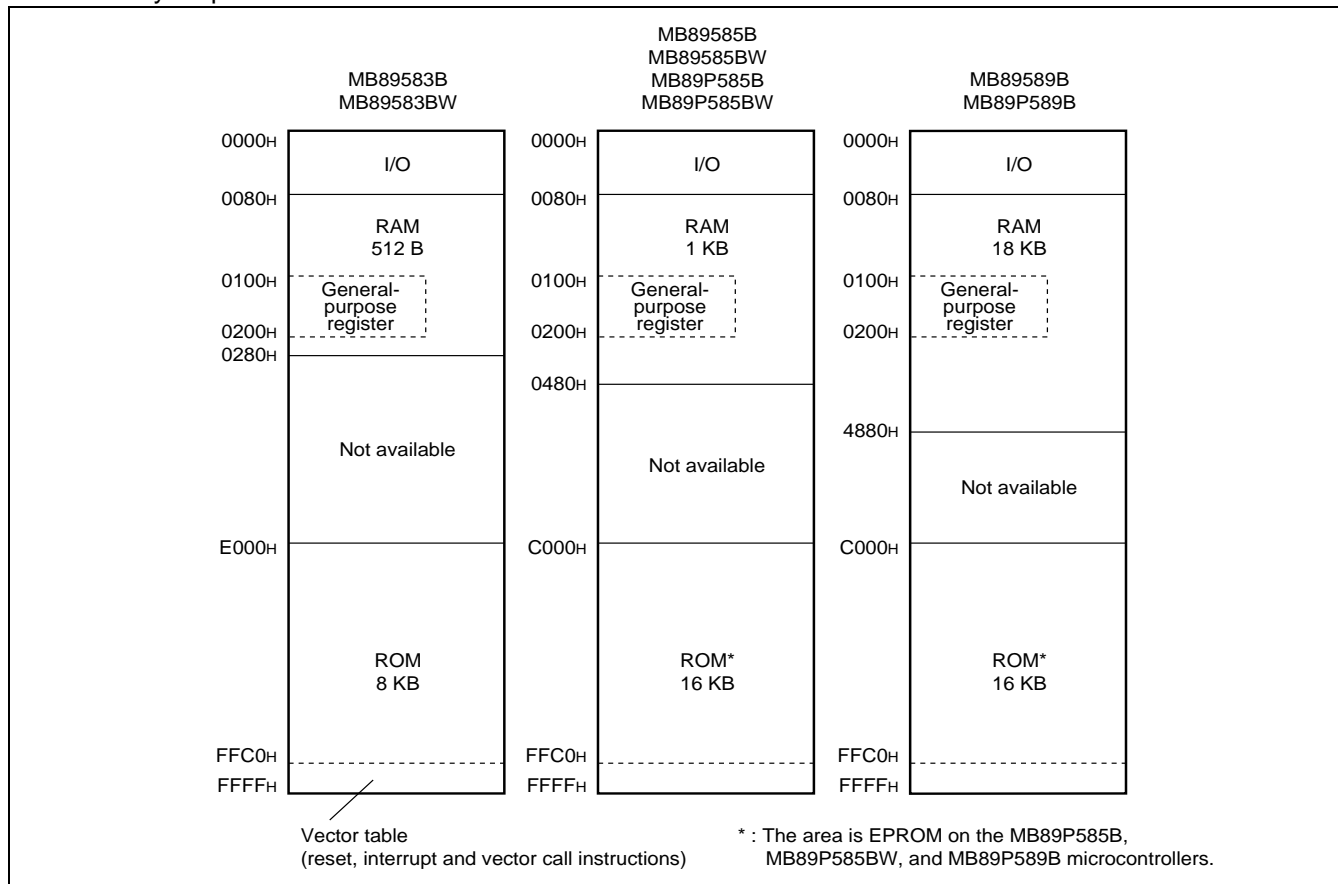
- ROM area

As an internal program area, a ROM is built in.

The internal ROM capacity varies with the product type.

The area FFC0H to FFFFH should be used for a vector table, for example.

- Memory map

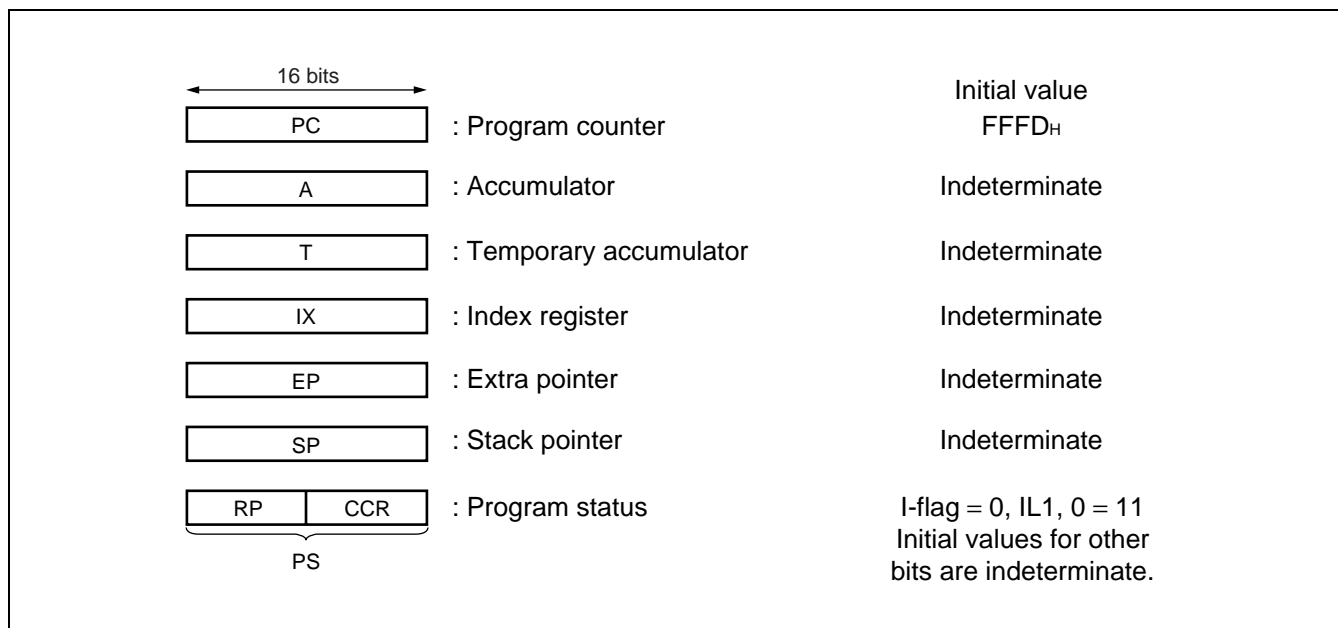


## 2. Registers

The MB89580B/BW series has two types of registers; the registers dedicated to specific purposes in the CPU and the general-purpose registers.

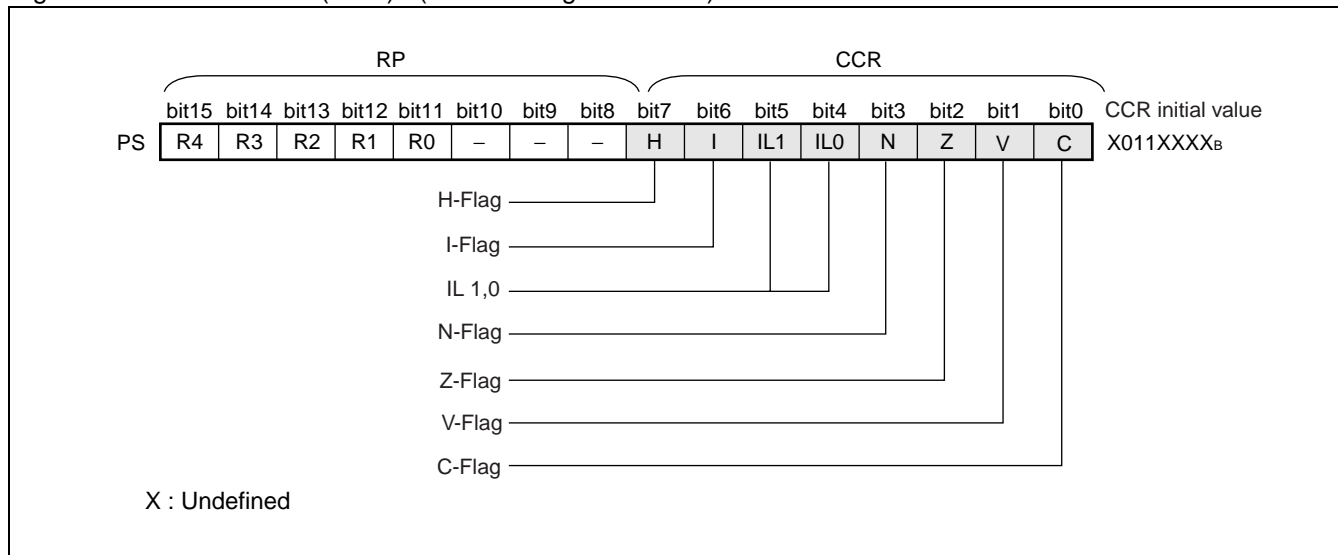
The dedicated registers are as follows:

- Program counter (PC) : A 16-bit register to indicate locations where instructions are stored.
- Accumulator (A) : A 16-bit register for temporary storage of operations. In the case of an 8-bit data processing instruction, the lower one byte is used.
- Temporary accumulator (T) : A 16-bit register which performs operations with the accumulator. In the case of an 8-bit data processing instruction, the lower one byte is used.
- Index register (IX) : A 16-bit register for index modification.
- Extra pointer (EP) : A 16-bit register to point to a memory address.
- Stack pointer (SP) : A 16-bit register to indicate a stack area.
- Program status (PS) : A 16-bit register to store a register pointer or a condition code.

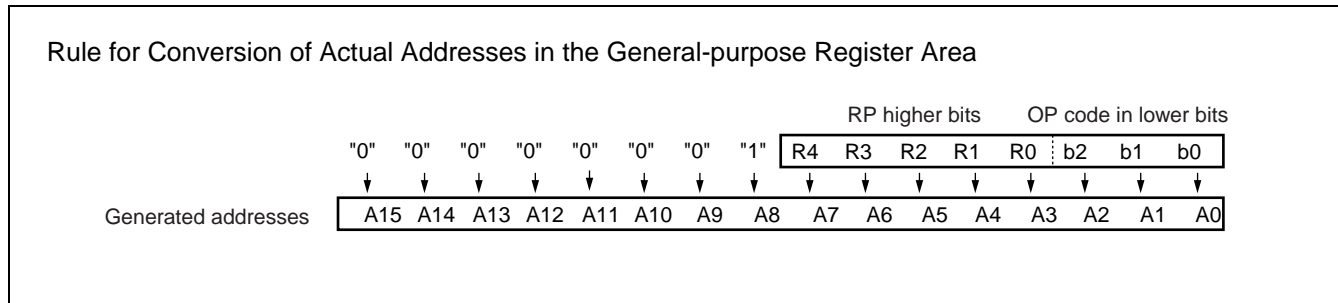


# MB89580B/580BW series

The PS register can further be divided into the register bank pointer in the higher 8 bits (RP) and the condition code register in the lower 8 bits (CCR) . (See the diagram below.)



The RP points to the address of the register bank currently in use. The relationship between the pointer contents and the actual address is based on the conversion rule shown next.



The CCR consists of the bits indicating arithmetic operation results or transfer data contents and the bits that control CPU operations at the time of an interrupt.

- H flag : The flag is set to "1" when an arithmetic operation results in a carry from bit 3 to bit 4 or in a borrow from bit 4 to bit 3. The bit is cleared to "0" in other instances. The flag is for decimal adjustment instructions; do not use for other than additions and subtractions.
- I flag : Interrupt is enabled when this flag is set to "1." Interrupt is disabled when this flag is set to "0." The flag is set to "0" when reset.
- IL1, 0 : Indicates the level of the interrupt currently enabled. An interrupt is processed only if its level is higher than the value this bit indicates.

IL1	IL0	Interrupt level	High-low
0	0	1	Higher
0	1		
1	0	2	Lower = no interruption
1	1	3	



# MB89580B/580BW series

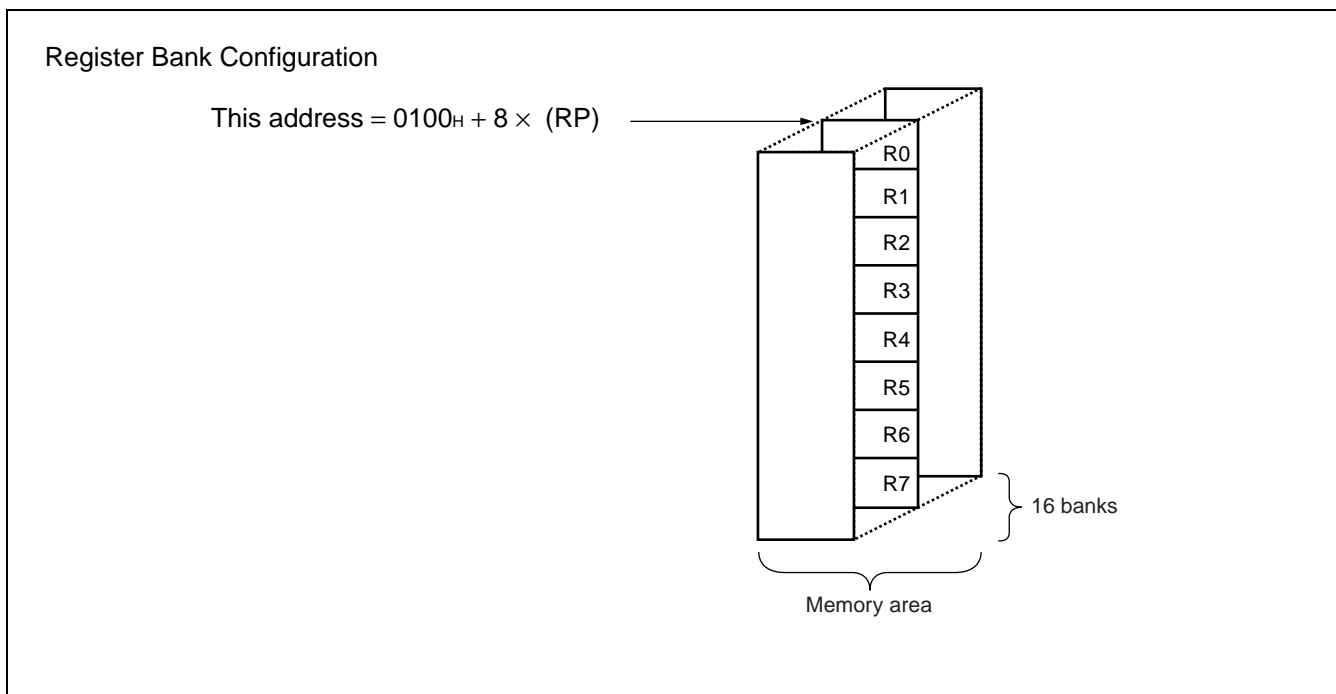
- N flag : The flag is set to "1" when an arithmetic operation results in setting of the MSB to "1" or is cleared to "0" when the MSB is set to "1."
- Z flag : The flag is set to "1" when an arithmetic operation results in "0" or is set to "0" in other instances.
- V flag : The flag is set to "1" when an arithmetic operation results in two's complement overflow or is cleared to "0" if no overflow occurs.
- C flag : The flag is set to "1" when an arithmetic operation results in a carry from bit 7 or in a borrow to bit 7. The flag is cleared to "0" if neither of them occurs. In the case of a shift instruction, the flag is set to the shift-out value.

The following general-purpose registers are provided:

General-purpose registers : 8-bit data storage registers

The general-purpose registers are 8 bits in length and located in the register banks in the memory. One bank contains eight registers and the MB89580B/BW microcontrollers allow a total of 16 banks to be used at maximum.

The bank currently in use is indicated by the register bank pointer (RP) .



# MB89580B/580BW series

## ■ I/O MAP

Address	Register name	Register description	Read/write	Initial value
00 <sub>H</sub>	PDR0	Port 0 data register	R/W	XXXXXXXX
01 <sub>H</sub>	DDR0	Port 0 direction register	W	00000000
02 <sub>H</sub>	PDR1	Port 1 data register	R/W	XXXXXXXX
03 <sub>H</sub>	DDR1	Port 1 direction register	W	00000000
04 <sub>H</sub>	PDR2	Port 2 data register	R/W	00000000
05 <sub>H</sub>	Vacancy			
06 <sub>H</sub>	Vacancy			
07 <sub>H</sub>	SYCC	System clock control register	R/W	XXX11X00
08 <sub>H</sub>	STBC	Standby control register	R/W	0001XXXX
09 <sub>H</sub>	WDTC	Watchdog timer control register	R/W	0XXXXXXXX
0A <sub>H</sub>	TBTC	Timebase timer control register	R/W	00XXX000
0B <sub>H</sub>	Vacancy			
0C <sub>H</sub>	PDR3	Port 3 data register	R/W	XXXXXXXX
0D <sub>H</sub>	DDR3	Port 3 direction register	R/W	00000000
0E <sub>H</sub>	Vacancy			
0F <sub>H</sub>	Vacancy			
10 <sub>H</sub>	PDR4	Port 4 data register	R/W	XXXXXXXX
11 <sub>H</sub>	DDR4	Port 4 direction register	R/W	00000000
12 <sub>H</sub>	PDR5	Port 5 data register	R/W	XXX111XX
13 <sub>H</sub>	DDR5	Port 5 direction register	R/W	XXXXXX00
14 <sub>H</sub>	PDR6	Port 6 data register	R/W	XXXXXXXX
15 <sub>H</sub>	PDCR	Parallel port data control register	R/W	XXX00000
16 <sub>H</sub> to 20 <sub>H</sub>	Vacancy			
21 <sub>H</sub>	PURR0	Port 0 pullup option setting register	R/W	11111111
22 <sub>H</sub>	PURR1	Port 1 pullup option setting register	R/W	11111111
23 <sub>H</sub>	PURR2	Port 2 pullup option setting register	R/W	11111111
24 <sub>H</sub>	PURR3	Port 3 pullup option setting register	R/W	11111111
25 <sub>H</sub>	PURR4	Port 4 pullup option setting register	R/W	11111111
26 <sub>H</sub>	PURR5	Port 5 pullup option setting register	R/W	XXX11111
27 <sub>H</sub>	CTR1	PWM control register 1	R/W	00000000
28 <sub>H</sub>	CTR2	PWM control register 2	R/W	000X0000
29 <sub>H</sub>	CTR3	PWM control register 3	R/W	X000XXXX
2A <sub>H</sub>	CMR1	PWM compare register 1	W	XXXXXXXX
2B <sub>H</sub>	CMR2	PWM compare register 2	W	XXXXXXXX

(Continued)

# MB89580B/580BW series

Address	Register name	Register description	Read/write	Initial value
2C <sub>H</sub>	CKR	Clock output control register	R/W	XXXXXXXX0
2D <sub>H</sub>	SCS	Serial clock switching register	R/W	XXXXXXXX0
2E <sub>H</sub>	Vacancy			
2F <sub>H</sub>	SMC1	Serial mode control register 1	R/W	00000000
30 <sub>H</sub>	SMC2	Serial mode control register 2	R/W	00000000
31 <sub>H</sub>	SSD	Serial status and control register	R	00001XXX
32 <sub>H</sub>	SIDR/SODR	Serial input/serial output data register	R/W	XXXXXXXXX
33 <sub>H</sub>	SRC	Serial rate control register	R/W	XXXXXXXXX
34 <sub>H</sub> to 3B <sub>H</sub>	Vacancy			
3C <sub>H</sub>	EIE	External interrupt control register	R/W	00000000
3D <sub>H</sub>	EIF	External interrupt flag register	R/W	XXXXXXXX0
3E <sub>H</sub> to 3F <sub>H</sub>	Vacancy			
40 <sub>H</sub>	DMDR	USB power supply mode register	R/W	XXXXXXXX0
41 <sub>H</sub> to 4E <sub>H</sub>	Vacancy			
4F <sub>H</sub>	DBARH	DMA base address register H	R/W	000000XX
50 <sub>H</sub>	UMDR	USB reset mode register	R/W	1000XX00
51 <sub>H</sub>	DBAR	DMA base address register	R/W	XXXXXXXXX
52 <sub>H</sub>	TDCR0	Transfer data count register 0	R/W	X0000000
53 <sub>H</sub>	TDCR11	Transfer data count register 11	R/W	00000000
54 <sub>H</sub>	TDCR12	Transfer data count register 12	R/W	XXXXXX00
55 <sub>H</sub>	TDCR21	Transfer data count register 21	R/W	00000000
56 <sub>H</sub>	TDCR22	Transfer data count register 22	R/W	XXXXXX00
57 <sub>H</sub>	TDCR3	Transfer data count register 3	R/W	X0000000
58 <sub>H</sub>	UCTR	USB control register	R/W	00000000
59 <sub>H</sub>	USTR1	USB status register 1	R/W	00000000
5A <sub>H</sub>	USTR2	USB status register 2	R	XXXXXX00
5B <sub>H</sub>	UMSKR	USB interrupt mask register	R/W	00000000
5C <sub>H</sub>	UFRMR1	USB frame status register 1	R	XXXXXXXXX
5D <sub>H</sub>	UFRMR2	USB frame status register 2	R	XXXXXXXXX
5E <sub>H</sub>	EPER	USB endpoint enable register	R/W	XXXX0001
5F <sub>H</sub>	EPBR0	Endpoint 0 setup register	R/W	X0000000
60 <sub>H</sub>	EPBR11	Endpoint setup register 11	R/W	0X000000
61 <sub>H</sub>	EPBR12	Endpoint setup register 12	R/W	00000000

(Continued)

# MB89580B/580BW series

(Continued)

Address	Register name	Register description	Read/write	Initial value
62 <sub>H</sub>	EPBR21	Endpoint setup register 21	R/W	0X000000
63 <sub>H</sub>	EPBR22	Endpoint setup register 22	R/W	00000000
64 <sub>H</sub>	EPBR31	Endpoint setup register 31	R/W	XX0000XX
65 <sub>H</sub>	EPBR32	Endpoint setup register 32	R/W	X0000000
66 <sub>H</sub> to 7B <sub>H</sub>	Vacancy			
7C <sub>H</sub>	ILR1	Interrupt level setting register 1	W	11111111
7D <sub>H</sub>	ILR2	Interrupt level setting register 2	W	11111111
7E <sub>H</sub>	ILR3	level setting register 3	W	11111111
7F <sub>H</sub>	Vacancy			
<ul style="list-style-type: none"> <li>• Information about read/write R/W : Read/write enabled, R : Read only, W : Write only</li> <li>• Information about initial values 0 : The initial value of this bit is "0." 1 : The initial bit of this bit is "1." X : The initial value of this bit is undefined.</li> </ul>				

Note : Vacancies are not for use.

## ■ ELECTRICAL CHARACTERISTICS

### 1. Absolute Maximum Ratings

( $V_{SS} = 0\text{ V}$ )

Parameter	Symbol	Value		Unit	Remarks
		Min.	Max.		
Power supply voltage	$V_{CC}$	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	
Input voltage	$V_I$	$V_{SS} - 0.3$	$V_{CC} + 0.3$	V	Other than P60 to P67
		$V_{SS} - 0.5$	$V_{SS} + 4.0$	V	P60 to P67
Output voltage	$V_O$	$V_{SS} - 0.3$	$V_{CC} + 0.3$	V	
"L" level average output current	$I_{OLAV}$	—	4	mA	Average value (operating current × operating rate)
"L" level total maximum output current	$\Sigma I_{OL}$	—	100	mA	
"L" level total average output current	$\Sigma I_{OLAV}$	—	40	mA	Average value (operating current × operating rate)
"H" level maximum output current	$I_{OH}$	—	-15	mA	
"H" level average output current	$I_{OHAV}$	—	-4	mA	Average value (operating current × operating rate)
"H" level total maximum output current	$\Sigma I_{OH}$	—	-50	mA	
"H" level total average output current	$\Sigma I_{OHAV}$	—	-20	mA	Average value (operating current × operating rate)
Power consumption	$P_D$	—	300	mW	
Operating temperature	$T_A$	-40	+85	°C	
Storage temperature	$T_{stg}$	-55	+150	°C	

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

# MB89580B/580BW series

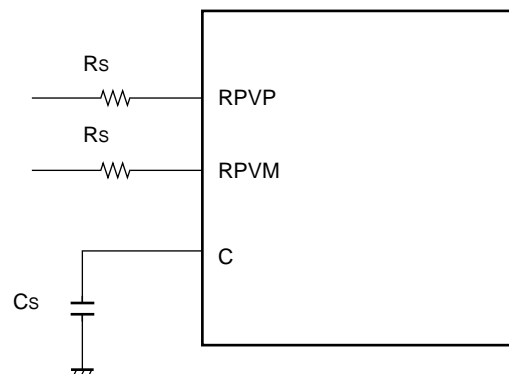
## 2. Recommended Operating Conditions

( $V_{SS} = 0\text{ V}$ )

Parameter	Symbol	Value			Unit	Remarks
		Min.	Typ.	Max.		
Power supply voltage	$V_{CC}$	3.0	—	5.5	V	
Operating temperature	$T_A$	-40	—	+85	°C	
Smoothing capacitor	$C_S$	0.1	—	1.0	$\mu\text{F}$	At $V_{CC} = 5.0\text{ V}^*$
Series resistance	$R_S$	—	16	—	$\Omega$	When the USB function is in use

\* : Use either a ceramic capacitor or a capacitor with similar frequency characteristics. The capacity of the smoothing capacitor for the  $V_{CC}$  pin should be greater than that of the  $C_S$ . When using with a supply voltage of 3.3 V, connect pin C with  $V_{CC}$  to input 3.3 V.

- C, RPVP and RPVM Pin Connection Diagram



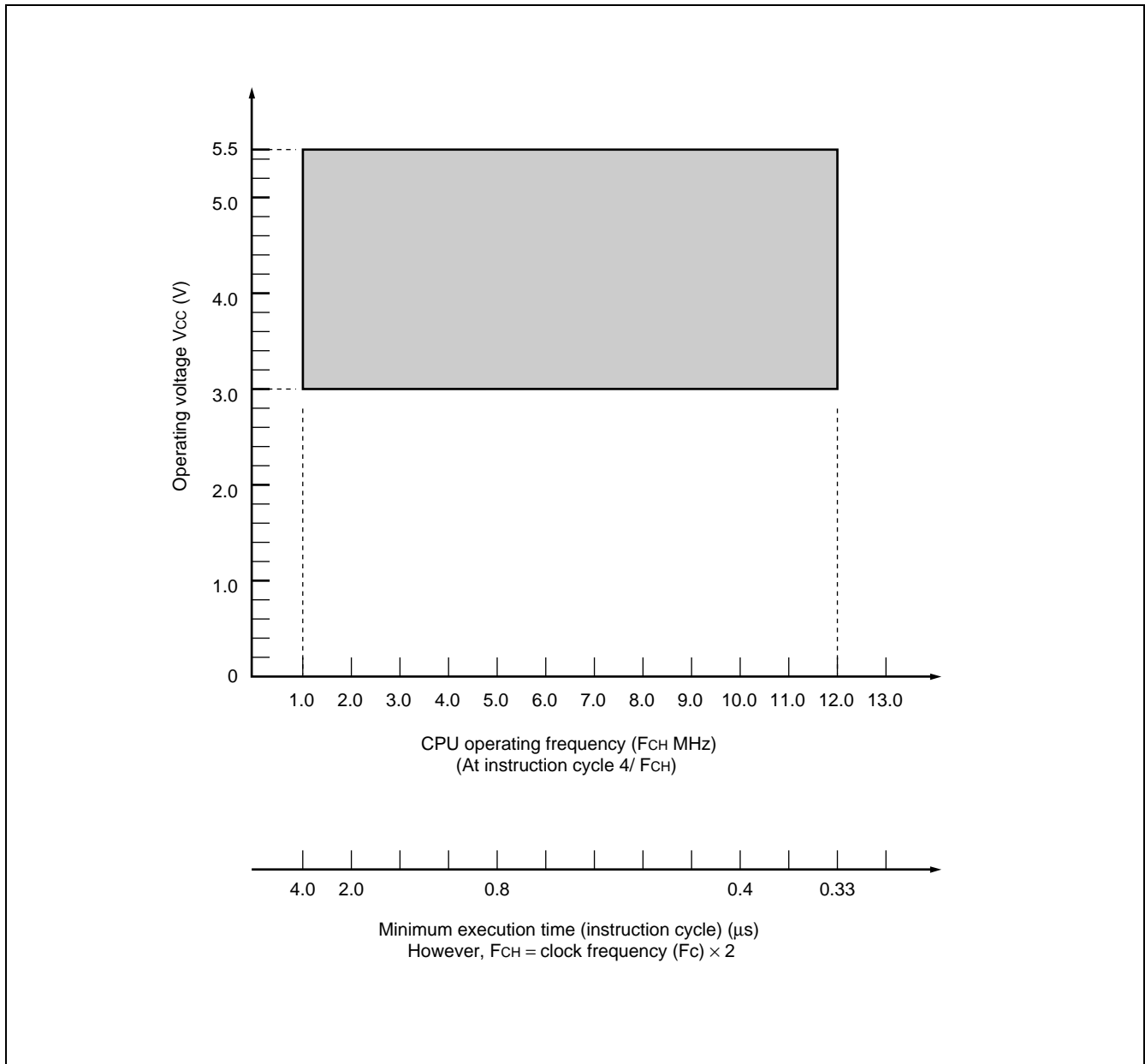


Figure 1 Operating voltage - operating frequency

**WARNING:** The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

# MB89580B/580BW series

## 3. DC Characteristics

( $V_{CC} = 5.0\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min.	Typ.	Max.		
"H" level input voltage	$V_{IH}$	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P54, MOD0, MOD1	—	$0.7 V_{CC}$	—	$V_{CC} + 0.3$	V	
	$V_{IHS}$	$\overline{RST}$ , $\overline{INT0}$ to $\overline{INT7}$ , UCK, UI	—	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	
	$V_{IH1}$	P60 to P67	—	$V_{SS} + 2.0$	—	$V_{SS} + 3.8$	V	
"L" level input voltage	$V_{IL}$	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P54, MOD0, MOD1	—	$V_{SS} - 0.3$	—	$0.3 V_{CC}$	V	
	$V_{ILS}$	$\overline{RST}$ , $\overline{INT0}$ to $\overline{INT7}$ , UCK, UI	—	$V_{SS} - 0.3$	—	$0.2 V_{CC}$	V	
	$V_{IL1}$	P60 to P67	—	$V_{SS} - 0.5$	—	$V_{SS} + 0.8$	V	
Open-drain output application voltage	$V_{D1}$	P52 to P54	—	$V_{SS} - 0.3$	—	$V_{CC} + 0.3$	V	
"H" level output voltage	$V_{OH}$	P00 to P07, P10 to P17, P20 to P24, P30 to P37, P40 to P47, P50, P51	$I_{OH} = -2.0\text{ mA}$	4.0	—	—	V	
"L" level output voltage	$V_{OL}$	P00 to P07, P10 to P17, P20 to P24, P30 to P37, P40 to P47, P50 to P54, $\overline{RST}$	$I_{OL} = 4.0\text{ mA}$	—	—	0.4	V	

(Continued)



# MB89580B/580BW series

(Continued)

( $V_{CC} = 5.0\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min.	Typ.	Max.		
Input leakage current (Hi-Z output leakage current)	$I_{LI}$	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50, P51, P60 to P67	$0.0 < V_i < V_{CC}$	-5	—	+5	$\mu\text{A}$	When no pullup resistance is specified
Open-drain output leakage current	$I_{LIOD}$	P52 to P54	$0.0 < V_i < V_{SS} + 5.5$	—	—	+5	$\mu\text{A}$	
Pullup resistance	$R_{PULL}$	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P54, $\overline{\text{RST}}$	$V_i = 0.0\text{ V}$	25	50	100	$\text{k}\Omega$	$\overline{\text{RST}}$ is excluded when pullup resistance available is specified.
Power supply current	$I_{CC}$	$V_{CC}$	$F_{CH} = 12.0\text{ MHz}$ $V_{CC} = 5.0\text{ V}$ $t_{inst} = 0.333\text{ }\mu\text{s}$	—	25	38	$\text{mA}$	MB89P585B/BW, MB89585B/BW, MB89583B/BW MB89P589B, MB89589B
	$I_{CCS1}$		$F_{CH} = 12.0\text{ MHz}$ $V_{CC} = 5.0\text{ V}$ $t_{inst} = 0.333\text{ }\mu\text{s}$	—	20	30	$\text{mA}$	Sleep mode
	$I_{CCH}$		$T_A = 25\text{ }^\circ\text{C}$	—	5	20	$\mu\text{A}$	Stop
Input capacitance	$C_{IN}$	Other than $V_{CC}$ and $V_{SS}$	$f = 1\text{ MHz}$	—	10	—	$\text{pF}$	

# MB89580B/580BW series

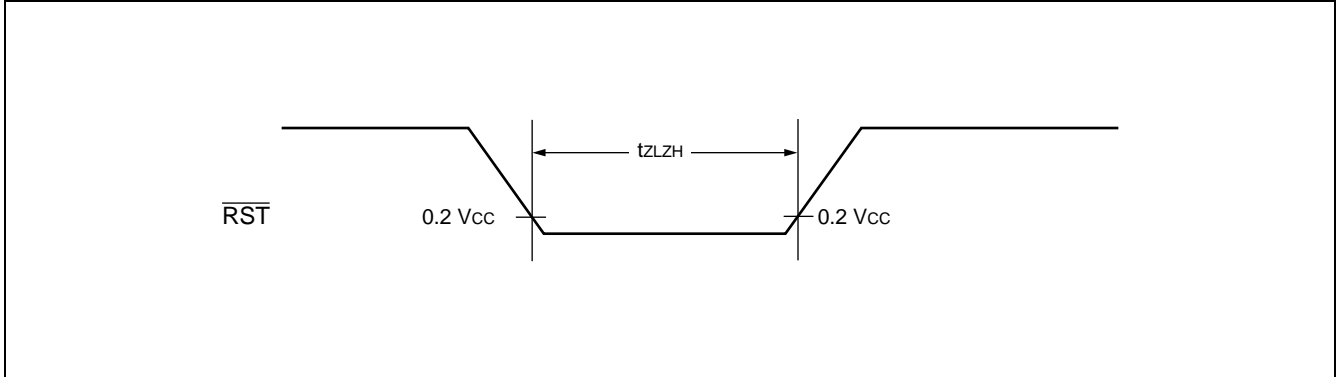
## 4. AC Characteristics

### (1) Reset Timing

( $V_{CC} = 5.0\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min.	Max.		
$\overline{\text{RST}}$ "L" pulse width	$t_{\text{ZLZH}}$	—	$16 t_{\text{HCLY}}$	—	ns	

Note :  $t_{\text{HCLY}}$  is the internal main clock oscillating cycle ( $1/2 F_c$ ) .



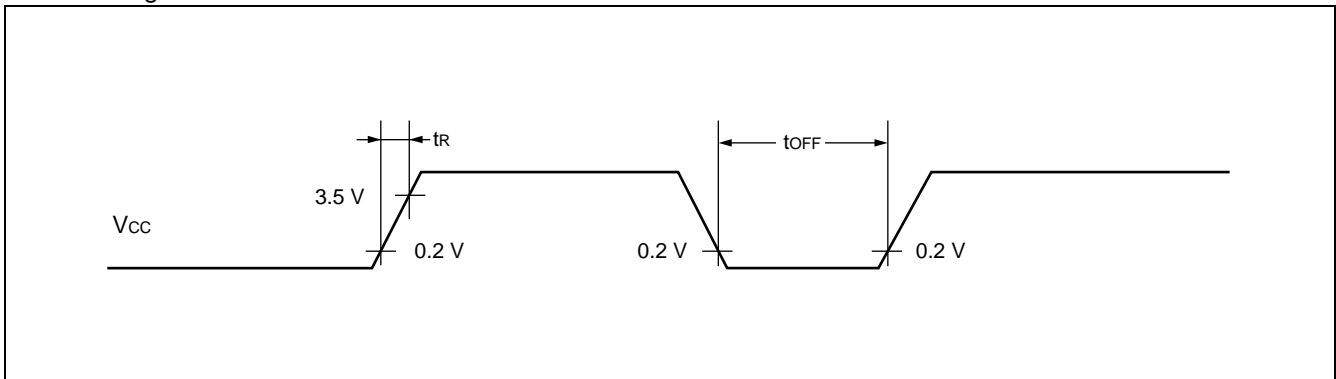
### (2) Power-on Reset and Power On Time

( $V_{SS} = 0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min.	Max.		
Power supply rising time	$t_{\text{R}}$	—	0.066	50	ms	
Power supply cutoff time	$t_{\text{OFF}}$	—	4	—	ns	Due to repeated operations

Note : The power supply must be up within the selected oscillation stabilization time.

When the supply voltage needs to be varied while operating, it is recommended to smoothly start up the voltage.



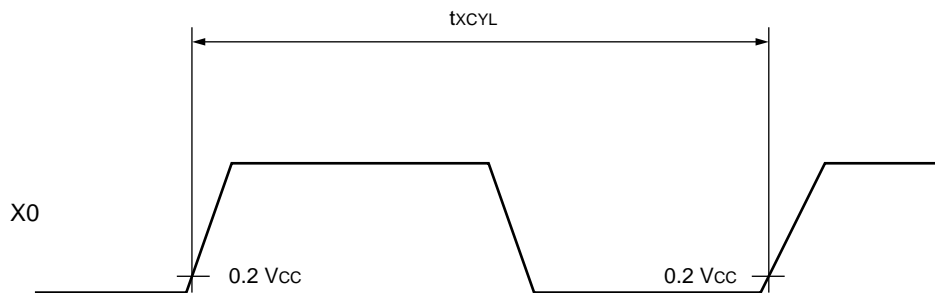
# MB89580B/580BW series

## (3) Clock Timing

( $V_{SS} = 0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

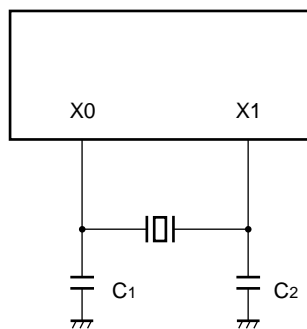
Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min.	Typ.	Max.		
Clock frequency	$F_C$	X0, X1	—	—	6	—	MHz	
Clock cycle time	$t_{XCYL}$	X0, X1		—	166.6	—	ns	
Internal main clock frequency	$F_{CH}$	—		—	12	—	MHz	Twice the $F_C$
Internal clock cycle	$t_{HCYL}$	—		—	83.3	—	ns	$t_{XCYL}/2$

- X0 and X1 Timing and Conditions



- Clock Conditions

When a crystal resonator is used



## (4) Instruction Cycle

( $V_{SS} = 0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

Parameter	Symbol	Value	Unit	Remarks
Instruction cycle (Min. execution time)	$t_{inst}$	$4 / F_{CH}$ , $8 / F_{CH}$ , $16 / F_{CH}$ , $64 / F_{CH}$	$\mu\text{s}$	When operating at $F_{CH} = 12\text{ MHz}$ $t_{inst} = 0.33\text{ }\mu\text{s}$ ( $4 / F_{CH}$ )

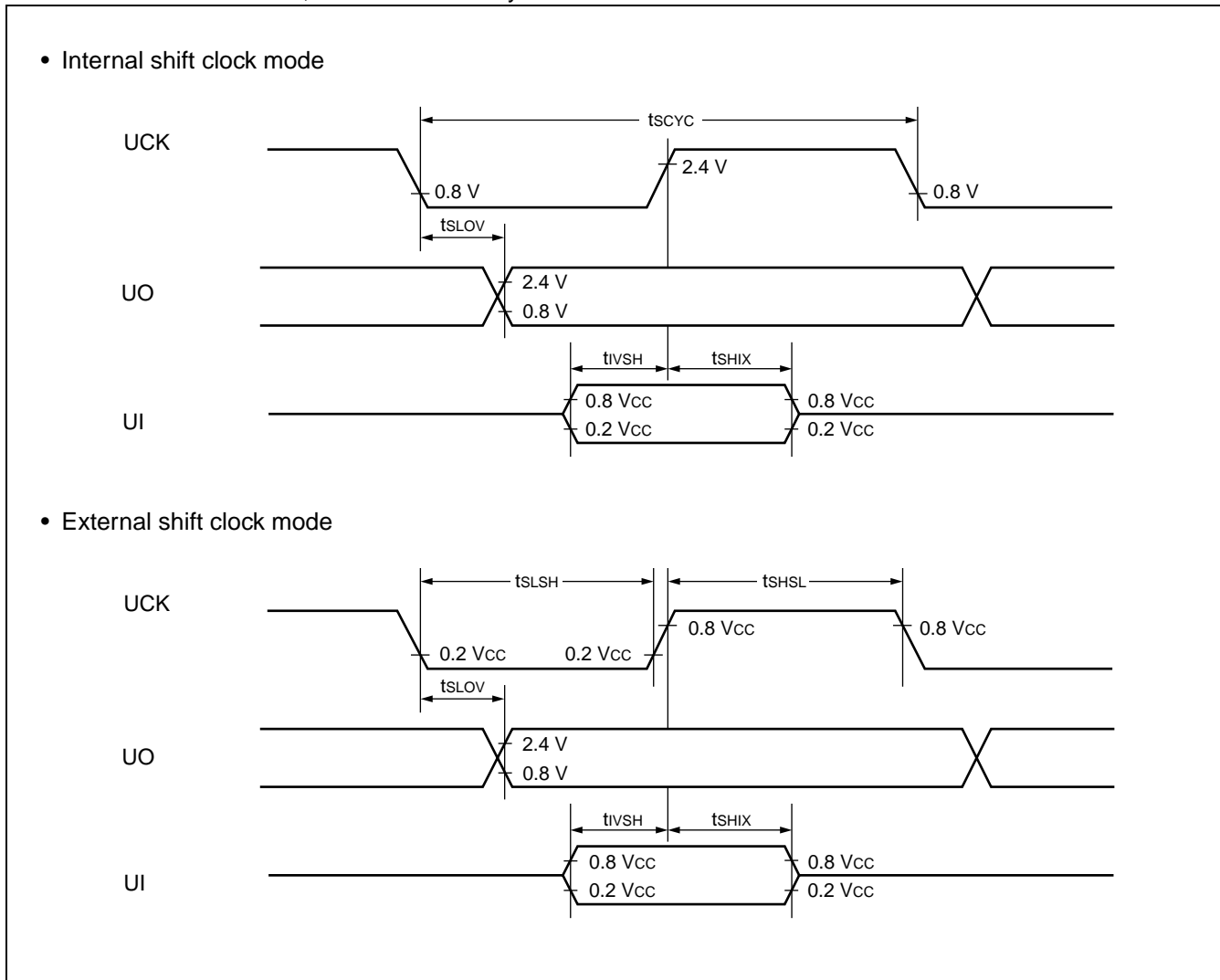
# MB89580B/580BW series

## (5) UART Serial I/O Timing

( $V_{CC} = 5.0\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Serial clock cycle time	$t_{SCYC}$	UCK	Internal shift clock mode	$2 t_{inst}$	—	$\mu\text{s}$	
UCK $\downarrow \rightarrow$ UO	$t_{SLOV}$	UCK, UO		-200	200	ns	
Valid UI $\rightarrow$ UCK $\uparrow$	$t_{VSH}$	UI, UCK		200	—	ns	
UCK $\uparrow \rightarrow$ valid UI hold time	$t_{SHIX}$	UCK, UI		200	—	ns	
Serial clock "H" pulse width	$t_{SHSL}$	UCK	External shift clock mode	$1 t_{inst}$	—	$\mu\text{s}$	
Serial clock "L" pulse width	$t_{SLSH}$			$1 t_{inst}$	—	$\mu\text{s}$	
UCK $\downarrow \rightarrow$ UO time	$t_{SLOV}$	UCK, UO		0	200	ns	
Valid UI $\rightarrow$ UCK $\uparrow$	$t_{VSH}$	UI, UCK		200	—	ns	
UCK $\uparrow \rightarrow$ valid UI hold time	$t_{SHIX}$	UCK, UI	200	—	ns		

\* : For information about  $t_{inst}$ , see "Instruction Cycle."



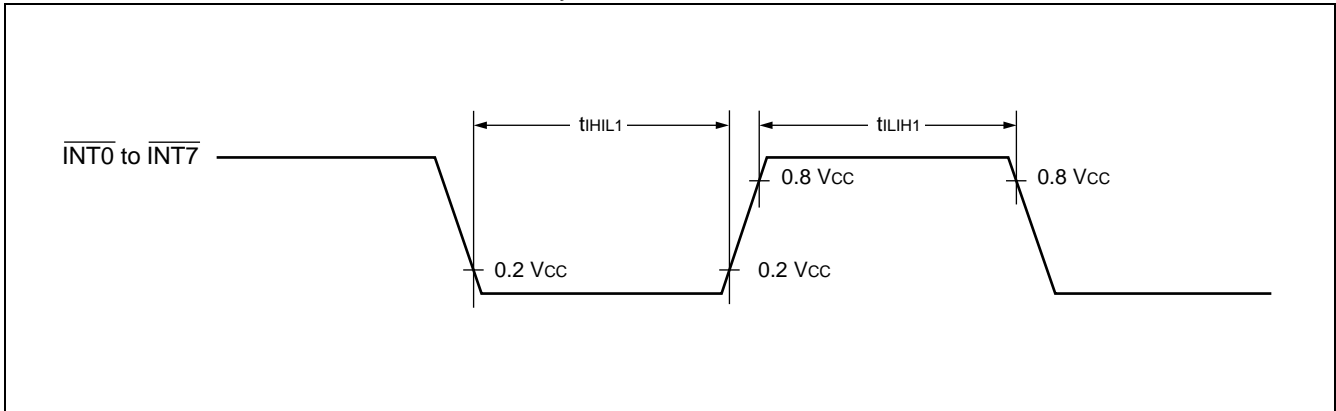
# MB89580B/580BW series

## (6) Peripheral Input Timing

( $V_{CC} = 5.0\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_A = -40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$ )

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
Peripheral input "H" pulse width 1	$t_{LIH1}$	$\overline{\text{INT0}}$ to $\overline{\text{INT7}}$	—	$2 t_{inst}$	—	$\mu\text{s}$	
Peripheral input "L" pulse width 1	$t_{HIL1}$		—	$2 t_{inst}$	—	$\mu\text{s}$	

\* : For information about  $t_{inst}$ , see "Instruction Cycle."



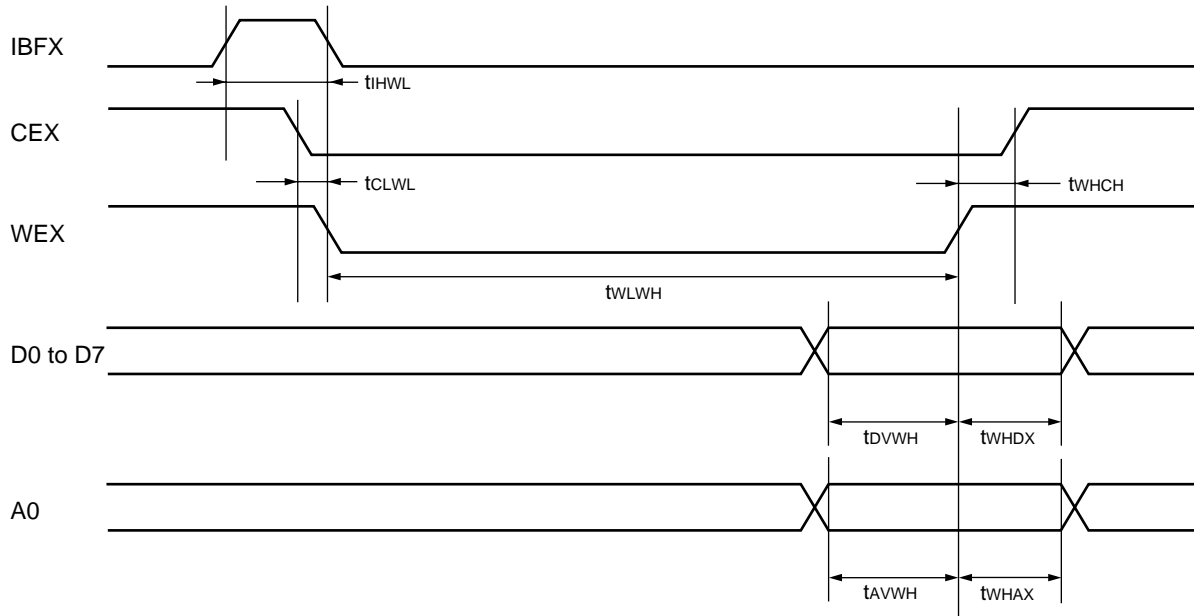
# MB89580B/580BW series

## (7) Parallel Port Timing

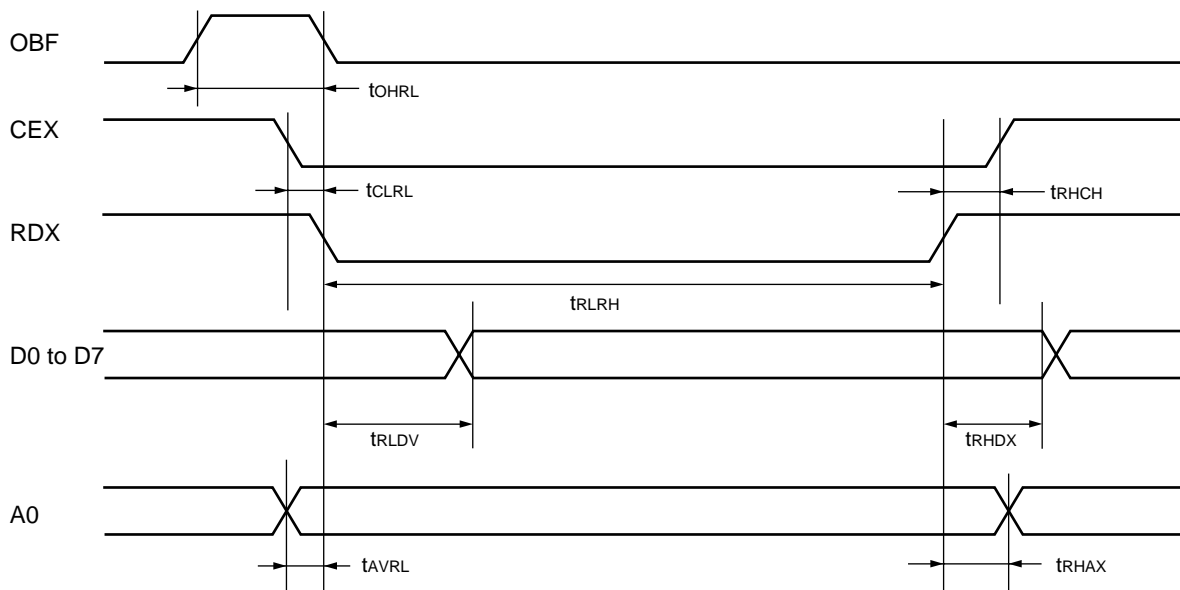
( $V_{CC} = 5.0\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_A = -40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$ )

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
IBFX $\uparrow \rightarrow$ WEX $\downarrow$ timing	$t_{IH\text{WL}}$	IBFX WEX	—	$1 / 2 \bullet t_{inst}$	—	$\mu\text{s}$	
CEX $\downarrow \rightarrow$ WEX $\downarrow$ delay	$t_{CL\text{WL}}$	CEX WEX	—	0	—	ns	
WEX $\uparrow \rightarrow$ CEX $\uparrow$ delay	$t_{WH\text{CH}}$	CEX WEX	—	0	—	ns	
WEX pulse width	$t_{WL\text{WH}}$	WEX	—	40	—	ns	
Write data setup	$t_{DV\text{WH}}$	D0 to D7 WEX	—	10	—	ns	
Write data hold	$t_{WH\text{DX}}$	D0 to D7 WEX	—	10	—	ns	
Write address setup	$t_{AV\text{WH}}$	A0 WEX	—	10	—	ns	
Write address hold	$t_{WH\text{AX}}$	A0 WEX	—	10	—	ns	
OBF $\uparrow \rightarrow$ RDX $\downarrow$ timing	$t_{OH\text{RL}}$	OBF RDX	—	$1 / 2 \bullet t_{inst}$	—	$\mu\text{s}$	
CEX $\downarrow \rightarrow$ RDX $\downarrow$ delay	$t_{CL\text{RL}}$	CEX RDX	—	0	—	ns	
RDX $\uparrow \rightarrow$ CEX $\uparrow$ delay	$t_{RH\text{CH}}$	CEX RDX	—	0	—	ns	
RDX pulse width	$t_{RL\text{RH}}$	RDX	—	40	—	ns	
Read data delay	$t_{RL\text{DV}}$	D0 to D7 RDX	—	—	15	ns	
Read data hold	$t_{RH\text{DX}}$	D0 to D7 RDX	—	0	—	ns	
Read address setup	$t_{AV\text{RL}}$	A0 RDX	—	10	—	ns	
Read address hold	$t_{RH\text{AX}}$	A0 RDX	—	10	—	ns	

## • Write Timing



## • Read Timing



# MB89580B/580BW series

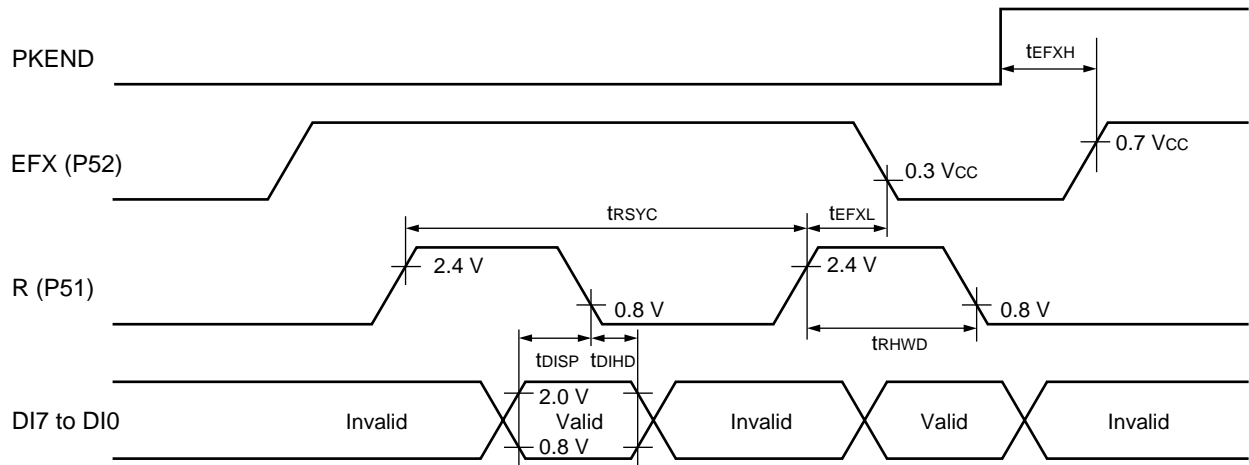
## (8) External FIFO Connection Timing

( $V_{CC} = 5.0\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ ,  $F_C = 6\text{ MHz}$ )

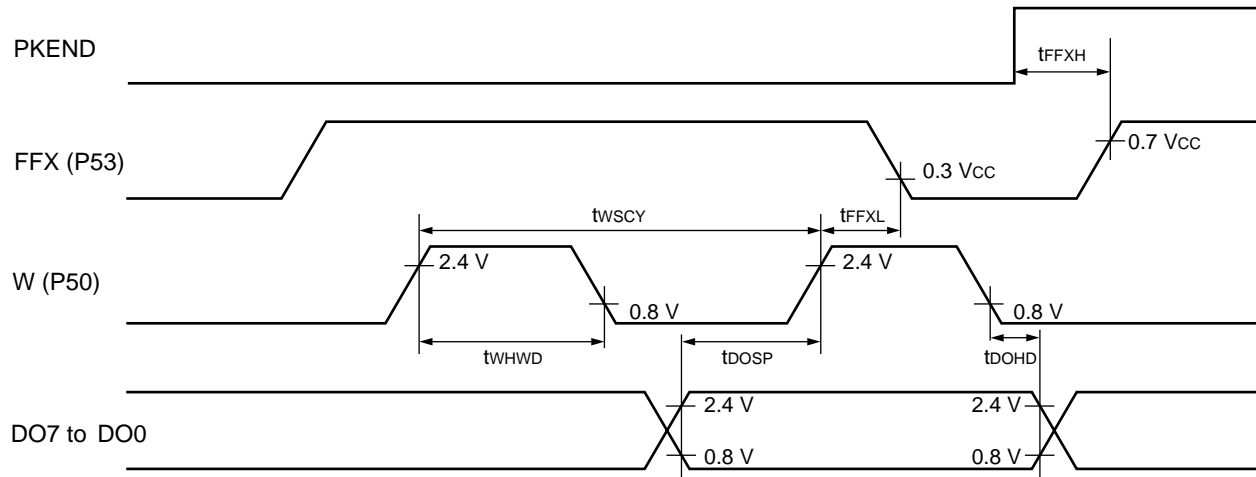
Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min.	Max.		
FIFO empty resetting timing	$t_{EFXH}$	EFX	Not including the initial resetting after reset	0	—	ns	Resetting before PKEND is not allowed.
FIFO empty timing	$t_{EFXL}$	EFX, R	—	0	360	ns	
Read cycle time	$t_{RSCY}$	R	—	645	—	ns	
Read clock "H" pulse width	$t_{RHWD}$		—	145	—	ns	
Valid DI $\rightarrow$ R $\downarrow$ setup time	$t_{DISP}$	DI7 to DI0, R	—	50	—	ns	
R $\downarrow$ $\rightarrow$ valid DI hold time	$t_{DIHD}$		—	0	—	ns	
FIFO full reset timing	$t_{FFXH}$	FFX	—	0	—	ns	Resetting before PKEND is not allowed.
FIFO full timing	$t_{FFXL}$	FFX, W	—	0	360	ns	
Write recycle time	$t_{WSCY}$	W	—	645	—	ns	
Write clock "H" pulse width	$t_{WHWD}$		—	145	—	ns	
Valid DO $\rightarrow$ W $\uparrow$ setup time	$t_{DOSP}$	DO7 to DO0, W	—	200	—	ns	
W $\downarrow$ $\rightarrow$ valid DO hold time	$t_{DOHD}$		—	40	—	ns	



- Read Data from External FIFO



- Write Data to External FIFO



# MB89580B/580BW series

## ■ INSTRUCTIONS (136 INSTRUCTIONS)

Execution instructions can be divided into the following four groups:

- Transfer
- Arithmetic operation
- Branch
- Others

Table 1 lists symbols used for notation of instructions.

**Table 1 Instruction Symbols**

Symbol	Meaning
dir	Direct address (8 bits)
off	Offset (8 bits)
ext	Extended address (16 bits)
#vct	Vector table number (3 bits)
#d8	Immediate data (8 bits)
#d16	Immediate data (16 bits)
dir: b	Bit direct address (8:3 bits)
rel	Branch relative address (8 bits)
@	Register indirect (Example: @A, @IX, @EP)
A	Accumulator A (Whether its length is 8 or 16 bits is determined by the instruction in use.)
AH	Upper 8 bits of accumulator A (8 bits)
AL	Lower 8 bits of accumulator A (8 bits)
T	Temporary accumulator T (Whether its length is 8 or 16 bits is determined by the instruction in use.)
TH	Upper 8 bits of temporary accumulator T (8 bits)
TL	Lower 8 bits of temporary accumulator T (8 bits)
IX	Index register IX (16 bits)
EP	Extra pointer EP (16 bits)
PC	Program counter PC (16 bits)
SP	Stack pointer SP (16 bits)
PS	Program status PS (16 bits)
dr	Accumulator A or index register IX (16 bits)
CCR	Condition code register CCR (8 bits)
RP	Register bank pointer RP (5 bits)
Ri	General-purpose register Ri (8 bits, i = 0 to 7)
×	Indicates that the very × is the immediate data. (Whether its length is 8 or 16 bits is determined by the instruction in use.)
(×)	Indicates that the contents of × is the target of accessing. (Whether its length is 8 or 16 bits is determined by the instruction in use.)
((×))	The address indicated by the contents of × is the target of accessing. (Whether its length is 8 or 16 bits is determined by the instruction in use.)

Columns indicate the following:

Mnemonic: Assembler notation of an instruction

~: The number of instructions

#: The number of bytes

Operation: Operation of an instruction

TL, TH, AH: A content change when each of the TL, TH, and AH instructions is executed. Symbols in the column indicate the following:

- “—” indicates no change.
- dH is the 8 upper bits of operation description data.
- AL and AH must become the contents of AL and AH prior to the instruction executed.
- 00 becomes 00.

N, Z, V, C: An instruction of which the corresponding flag will change. If + is written in this column, the relevant instruction will change its corresponding flag.

OP code: Code of an instruction. If an instruction is more than one code, it is written according to the following rule:  
Example: 48 to 4F ← This indicates 48, 49, ... 4F.

# MB89580B/580BW series

Table 2 Transfer Instructions (48 instructions)

Mnemonic	~	#	Operation	TL	TH	AH	NZVC	OP code
MOV dir,A	3	2	(dir) ← (A)	-	-	-	-----	45
MOV @IX +off,A	4	2	((IX) +off) ← (A)	-	-	-	-----	46
MOV ext,A	4	3	(ext) ← (A)	-	-	-	-----	61
MOV @EP,A	3	1	((EP)) ← (A)	-	-	-	-----	47
MOV Ri,A	3	1	(Ri) ← (A)	-	-	-	-----	48 to 4F
MOV A,#d8	2	2	(A) ← d8	AL	-	-	++--	04
MOV A,dir	3	2	(A) ← (dir)	AL	-	-	++--	05
MOV A,@IX +off	4	2	(A) ← ((IX) +off)	AL	-	-	++--	06
MOV A,ext	4	3	(A) ← (ext)	AL	-	-	++--	60
MOV A,@A	3	1	(A) ← ((A))	AL	-	-	++--	92
MOV A,@EP	3	1	(A) ← ((EP))	AL	-	-	++--	07
MOV A,Ri	3	1	(A) ← (Ri)	AL	-	-	++--	08 to 0F
MOV dir,#d8	4	3	(dir) ← d8	-	-	-	-----	85
MOV @IX +off,#d8	5	3	((IX) +off) ← d8	-	-	-	-----	86
MOV @EP,#d8	4	2	((EP)) ← d8	-	-	-	-----	87
MOV Ri,#d8	4	2	(Ri) ← d8	-	-	-	-----	88 to 8F
MOVW dir,A	4	2	(dir) ← (AH),(dir + 1) ← (AL)	-	-	-	-----	D5
MOVW @IX +off,A	5	2	((IX) +off) ← (AH), ((IX) +off + 1) ← (AL)	-	-	-	-----	D6
MOVW ext,A	5	3	(ext) ← (AH), (ext + 1) ← (AL)	-	-	-	-----	D4
MOVW @EP,A	4	1	((EP)) ← (AH),(EP) + 1) ← (AL)	-	-	-	-----	D7
MOVW EP,A	2	1	(EP) ← (A)	-	-	-	-----	E3
MOVW A,#d16	3	3	(A) ← d16	AL	AH	dH	++--	E4
MOVW A,dir	4	2	(AH) ← (dir), (AL) ← (dir + 1)	AL	AH	dH	++--	C5
MOVW A,@IX +off	5	2	(AH) ← ((IX) +off), (AL) ← ((IX) +off + 1)	AL	AH	dH	++--	C6
MOVW A,ext	5	3	(AH) ← (ext), (AL) ← (ext + 1)	AL	AH	dH	++--	C4
MOVW A,@A	4	1	(AH) ← ((A)), (AL) ← ((A) + 1)	AL	AH	dH	++--	93
MOVW A,@EP	4	1	(AH) ← ((EP)), (AL) ← ((EP) + 1)	AL	AH	dH	++--	C7
MOVW A,EP	2	1	(A) ← (EP)	-	-	dH	-----	F3
MOVW EP,#d16	3	3	(EP) ← d16	-	-	-	-----	E7
MOVW IX,A	2	1	(IX) ← (A)	-	-	-	-----	E2
MOVW A,IX	2	1	(A) ← (IX)	-	-	dH	-----	F2
MOVW SP,A	2	1	(SP) ← (A)	-	-	-	-----	E1
MOVW A,SP	2	1	(A) ← (SP)	-	-	dH	-----	F1
MOV @A,T	3	1	((A)) ← (T)	-	-	-	-----	82
MOVW @A,T	4	1	((A)) ← (TH),(A) + 1) ← (TL)	-	-	-	-----	83
MOVW IX,#d16	3	3	(IX) ← d16	-	-	-	-----	E6
MOVW A,PS	2	1	(A) ← (PS)	-	-	dH	-----	70
MOVW PS,A	2	1	(PS) ← (A)	-	-	-	++++	71
MOVW SP,#d16	3	3	(SP) ← d16	-	-	-	-----	E5
SWAP	2	1	(AH) ↔ (AL)	-	-	AL	-----	10
SETB dir: b	4	2	(dir): b ← 1	-	-	-	-----	A8 to AF
CLRB dir: b	4	2	(dir): b ← 0	-	-	-	-----	A0 to A7
XCH A,T	2	1	(AL) ↔ (TL)	AL	-	-	-----	42
XCHW A,T	3	1	(A) ↔ (T)	AL	AH	dH	-----	43
XCHW A,EP	3	1	(A) ↔ (EP)	-	-	dH	-----	F7
XCHW A,IX	3	1	(A) ↔ (IX)	-	-	dH	-----	F6
XCHW A,SP	3	1	(A) ↔ (SP)	-	-	dH	-----	F5
MOVW A,PC	2	1	(A) ← (PC)	-	-	dH	-----	F0

Note During byte transfer to A, T ← A is restricted to low bytes.

Operands in more than one operand instruction must be stored in the order in which their mnemonics are written. (Reverse arrangement of F<sup>2</sup>MC-8 family)

# MB89580B/580BW series

**Table 3 Arithmetic Operation Instructions (62 instructions)**

Mnemonic	~	#	Operation	TL	TH	AH	NZVC	OP code
ADDC A,Ri	3	1	$(A) \leftarrow (A) + (Ri) + C$	-	-	-	++++	28 to 2F
ADDC A,#d8	2	2	$(A) \leftarrow (A) + d8 + C$	-	-	-	++++	24
ADDC A,dir	3	2	$(A) \leftarrow (A) + (dir) + C$	-	-	-	++++	25
ADDC A,@IX +off	4	2	$(A) \leftarrow (A) + ((IX) + off) + C$	-	-	-	++++	26
ADDC A,@EP	3	1	$(A) \leftarrow (A) + ((EP)) + C$	-	-	-	++++	27
ADDCW A	3	1	$(A) \leftarrow (A) + (T) + C$	-	-	dH	++++	23
ADDC A	2	1	$(AL) \leftarrow (AL) + (TL) + C$	-	-	-	++++	22
SUBC A,Ri	3	1	$(A) \leftarrow (A) - (Ri) - C$	-	-	-	++++	38 to 3F
SUBC A,#d8	2	2	$(A) \leftarrow (A) - d8 - C$	-	-	-	++++	34
SUBC A,dir	3	2	$(A) \leftarrow (A) - (dir) - C$	-	-	-	++++	35
SUBC A,@IX +off	4	2	$(A) \leftarrow (A) - ((IX) + off) - C$	-	-	-	++++	36
SUBC A,@EP	3	1	$(A) \leftarrow (A) - ((EP)) - C$	-	-	-	++++	37
SUBCW A	3	1	$(A) \leftarrow (T) - (A) - C$	-	-	dH	++++	33
SUBC A	2	1	$(AL) \leftarrow (TL) - (AL) - C$	-	-	-	++++	32
INC Ri	4	1	$(Ri) \leftarrow (Ri) + 1$	-	-	-	+++-	C8 to CF
INCW EP	3	1	$(EP) \leftarrow (EP) + 1$	-	-	-	----	C3
INCW IX	3	1	$(IX) \leftarrow (IX) + 1$	-	-	-	----	C2
INCW A	3	1	$(A) \leftarrow (A) + 1$	-	-	dH	++--	C0
DEC Ri	4	1	$(Ri) \leftarrow (Ri) - 1$	-	-	-	+++-	D8 to DF
DECW EP	3	1	$(EP) \leftarrow (EP) - 1$	-	-	-	----	D3
DECW IX	3	1	$(IX) \leftarrow (IX) - 1$	-	-	-	----	D2
DECW A	3	1	$(A) \leftarrow (A) - 1$	-	-	dH	++--	D0
MULU A	19	1	$(A) \leftarrow (AL) \times (TL)$	-	-	dH	----	01
DIVU A	21	1	$(A) \leftarrow (T) / (AL), MOD \rightarrow (T)$	dL	00	00	----	11
ANDW A	3	1	$(A) \leftarrow (A) \wedge (T)$	-	-	dH	++R-	63
ORW A	3	1	$(A) \leftarrow (A) \vee (T)$	-	-	dH	++R-	73
XORW A	3	1	$(A) \leftarrow (A) \nabla (T)$	-	-	dH	++R-	53
CMP A	2	1	$(TL) - (AL)$	-	-	-	++++	12
CMPW A	3	1	$(T) - (A)$	-	-	-	++++	13
RORC A	2	1	$\rightarrow C \rightarrow A$	-	-	-	++-+	03
ROLC A	2	1	$\leftarrow C \leftarrow A$	-	-	-	++-+	02
CMP A,#d8	2	2	$(A) - d8$	-	-	-	++++	14
CMP A,dir	3	2	$(A) - (dir)$	-	-	-	++++	15
CMP A,@EP	3	1	$(A) - ((EP))$	-	-	-	++++	17
CMP A,@IX +off	4	2	$(A) - ((IX) + off)$	-	-	-	++++	16
CMP A,Ri	3	1	$(A) - (Ri)$	-	-	-	++++	18 to 1F
DAA	2	1	Decimal adjust for addition	-	-	-	++++	84
DAS	2	1	Decimal adjust for subtraction	-	-	-	++++	94
XOR A	2	1	$(A) \leftarrow (AL) \nabla (TL)$	-	-	-	++R-	52
XOR A,#d8	2	2	$(A) \leftarrow (AL) \nabla d8$	-	-	-	++R-	54
XOR A,dir	3	2	$(A) \leftarrow (AL) \nabla (dir)$	-	-	-	++R-	55
XOR A,@EP	3	1	$(A) \leftarrow (AL) \nabla ((EP))$	-	-	-	++R-	57
XOR A,@IX +off	4	2	$(A) \leftarrow (AL) \nabla ((IX) + off)$	-	-	-	++R-	56
XOR A,Ri	3	1	$(A) \leftarrow (AL) \nabla (Ri)$	-	-	-	++R-	58 to 5F
AND A	2	1	$(A) \leftarrow (AL) \wedge (TL)$	-	-	-	++R-	62
AND A,#d8	2	2	$(A) \leftarrow (AL) \wedge d8$	-	-	-	++R-	64
AND A,dir	3	2	$(A) \leftarrow (AL) \wedge (dir)$	-	-	-	++R-	65

(Continued)

# MB89580B/580BW series

(Continued)

Mnemonic	~	#	Operation	TL	TH	AH	NZVC	OP code
AND A,@EP	3	1	$(A) \leftarrow (AL) \wedge (EP)$	-	-	-	++R-	67
AND A,@IX +off	4	2	$(A) \leftarrow (AL) \wedge ((IX) + \text{off})$	-	-	-	++R-	66
AND A,Ri	3	1	$(A) \leftarrow (AL) \wedge (Ri)$	-	-	-	++R-	68 to 6F
OR A	2	1	$(A) \leftarrow (AL) \vee (TL)$	-	-	-	++R-	72
OR A,#d8	2	2	$(A) \leftarrow (AL) \vee d8$	-	-	-	++R-	74
OR A,dir	3	2	$(A) \leftarrow (AL) \vee (\text{dir})$	-	-	-	++R-	75
OR A,@EP	3	1	$(A) \leftarrow (AL) \vee (EP)$	-	-	-	++R-	77
OR A,@IX +off	4	2	$(A) \leftarrow (AL) \vee ((IX) + \text{off})$	-	-	-	++R-	76
OR A,Ri	3	1	$(A) \leftarrow (AL) \vee (Ri)$	-	-	-	++R-	78 to 7F
CMP dir,#d8	5	3	$(\text{dir}) - d8$	-	-	-	++++	95
CMP @EP,#d8	4	2	$(EP) - d8$	-	-	-	++++	97
CMP @IX +off,#d8	5	3	$((IX) + \text{off}) - d8$	-	-	-	++++	96
CMP Ri,#d8	4	2	$(Ri) - d8$	-	-	-	++++	98 to 9F
INCW SP	3	1	$(SP) \leftarrow (SP) + 1$	-	-	-	----	C1
DECW SP	3	1	$(SP) \leftarrow (SP) - 1$	-	-	-	----	D1

**Table 4 Branch Instructions (17 instructions)**

Mnemonic	~	#	Operation	TL	TH	AH	NZVC	OP code
BZ/BEQ rel	3	2	If $Z = 1$ then $PC \leftarrow PC + \text{rel}$	-	-	-	----	FD
BNZ/BNE rel	3	2	If $Z = 0$ then $PC \leftarrow PC + \text{rel}$	-	-	-	----	FC
BC/BLO rel	3	2	If $C = 1$ then $PC \leftarrow PC + \text{rel}$	-	-	-	----	F9
BNC/BHS rel	3	2	If $C = 0$ then $PC \leftarrow PC + \text{rel}$	-	-	-	----	F8
BN rel	3	2	If $N = 1$ then $PC \leftarrow PC + \text{rel}$	-	-	-	----	FB
BP rel	3	2	If $N = 0$ then $PC \leftarrow PC + \text{rel}$	-	-	-	----	FA
BLT rel	3	2	If $V \vee N = 1$ then $PC \leftarrow PC + \text{rel}$	-	-	-	----	FF
BGE rel	3	2	If $V \vee N = 0$ then $PC \leftarrow PC + \text{rel}$	-	-	-	----	FE
BBC dir: b,rel	5	3	If $(\text{dir: } b) = 0$ then $PC \leftarrow PC + \text{rel}$	-	-	-	-+---	B0 to B7
BBS dir: b,rel	5	3	If $(\text{dir: } b) = 1$ then $PC \leftarrow PC + \text{rel}$	-	-	-	-+---	B8 to BF
JMP @A	2	1	$(PC) \leftarrow (A)$	-	-	-	----	E0
JMP ext	3	3	$(PC) \leftarrow \text{ext}$	-	-	-	----	21
CALLV #vct	6	1	Vector call	-	-	-	----	E8 to EF
CALL ext	6	3	Subroutine call	-	-	-	----	31
XCHW A,PC	3	1	$(PC) \leftarrow (A), (A) \leftarrow (PC) + 1$	-	-	dH	----	F4
RET	4	1	Return from subroutine	-	-	-	----	20
RETI	6	1	Return from interrupt	-	-	-	Restore	30

**Table 5 Other Instructions (9 instructions)**

Mnemonic	~	#	Operation	TL	TH	AH	NZVC	OP code
PUSHW A	4	1		-	-	-	----	40
POPW A	4	1		-	-	dH	----	50
PUSHW IX	4	1		-	-	-	----	41
POPW IX	4	1		-	-	-	----	51
NOP	1	1		-	-	-	----	00
CLRC	1	1		-	-	-	----R	81
SETC	1	1		-	-	-	----S	91
CLRI	1	1		-	-	-	----	80
SETI	1	1		-	-	-	----	90

# MB89580B/580BW series

## INSTRUCTION MAP

L	H	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0	NOP	SWAP	RET	RETI	PUSHW A	PUSHW A	POPW A	MOV A,ext	MOVW A,PS	CLR	SETI	CLRB dir: 0	BBC dir: 0,rel	INCW A	DECW A	JMP @A	MOVW A,PC
1	MULU A	DIVU A	JMP addr16	CALL addr16	PUSHW IX	PUSHW IX	POPW IX	MOV ext,A	MOVW PS,A	CLRC	SETC	CLRB dir: 1	BBC dir: 1,rel	INCW SP	DECW SP	MOVW SPA	MOVW A,SP
2	ROLC A	CMP A	ADDC A	SUBC A	XCH A,T	XCH A,T	XOR A	AND A	OR A	MOV @A,T	MOV A,@A	CLRB dir: 2	BBC dir: 2,rel	INCW IX	DECW IX	MOVW IX,A	MOVW A,IX
3	RORC A	CMPW A	ADDCW A	SUBCW A	XCHW A,T	XCHW A,T	XORW A	ANDW A	ORW A	MOVW @A,T	MOVW A,@A	CLRB dir: 3	BBC dir: 3,rel	INCW EP	DECW EP	MOVW EPA	MOVW A,EP
4	MOV A,#d8	CMP A,#d8	ADDC A,#d8	SUBC A,#d8	XOR A,#d8	XOR A,#d8	XOR A,#d8	AND A,#d8	OR A,#d8	DAA	DAS	CLRB dir: 4	BBC dir: 4,rel	MOVW A,ext	MOVW ext,A	MOVW A,#d16	XCHW A,PC
5	MOV A,dir	CMP A,dir	ADDC A,dir	SUBC A,dir	XOR A,dir	MOV dir,A	XOR A,dir	AND A,dir	OR A,dir	MOV dir,#d8	CMP dir,#d8	CLRB dir: 5	BBC dir: 5,rel	MOVW A,dir	MOVW dir,A	MOVW SP#d16	XCHW A,SP
6	MOV A,@IX+d	CMP A,@IX+d	ADDC A,@IX+d	SUBC A,@IX+d	XOR A,@IX+d	MOV @IX+d,A	XOR A,@IX+d	AND A,@IX+d	OR A,@IX+d	MOV @IX+d,#d8	CMP @IX+d,#d8	CLRB dir: 6	BBC dir: 6,rel	MOVW A,@IX+d	MOVW @IX+d,A	MOVW IX#d16	XCHW A,IX
7	MOV A,@EP	CMP A,@EP	ADDC A,@EP	SUBC A,@EP	XOR A,@EP	MOV @EP,A	XOR A,@EP	AND A,@EP	OR A,@EP	MOV @EP#d8	CMP @EP#d8	CLRB dir: 7	BBC dir: 7,rel	MOVW A,@EP	MOVW @EP,A	MOVW EP#d16	XCHW A,EP
8	MOV A,R0	CMP A,R0	ADDC A,R0	SUBC A,R0	XOR A,R0	MOV R0,A	XOR A,R0	AND A,R0	OR A,R0	MOV R0,#d8	CMP R0,#d8	SETB dir: 0	BBS dir: 0,rel	INC R0	DEC R0	CALLV #0	BNC rel
9	MOV A,R1	CMP A,R1	ADDC A,R1	SUBC A,R1	XOR A,R1	MOV R1,A	XOR A,R1	AND A,R1	OR A,R1	MOV R1,#d8	CMP R1,#d8	SETB dir: 1	BBS dir: 1,rel	INC R1	DEC R1	CALLV #1	BC rel
A	MOV A,R2	CMP A,R2	ADDC A,R2	SUBC A,R2	XOR A,R2	MOV R2,A	XOR A,R2	AND A,R2	OR A,R2	MOV R2,#d8	CMP R2,#d8	SETB dir: 2	BBS dir: 2,rel	INC R2	DEC R2	CALLV #2	BP rel
B	MOV A,R3	CMP A,R3	ADDC A,R3	SUBC A,R3	XOR A,R3	MOV R3,A	XOR A,R3	AND A,R3	OR A,R3	MOV R3,#d8	CMP R3,#d8	SETB dir: 3	BBS dir: 3,rel	INC R3	DEC R3	CALLV #3	BN rel
C	MOV A,R4	CMP A,R4	ADDC A,R4	SUBC A,R4	XOR A,R4	MOV R4,A	XOR A,R4	AND A,R4	OR A,R4	MOV R4,#d8	CMP R4,#d8	SETB dir: 4	BBS dir: 4,rel	INC R4	DEC R4	CALLV #4	BNZ rel
D	MOV A,R5	CMP A,R5	ADDC A,R5	SUBC A,R5	XOR A,R5	MOV R5,A	XOR A,R5	AND A,R5	OR A,R5	MOV R5,#d8	CMP R5,#d8	SETB dir: 5	BBS dir: 5,rel	INC R5	DEC R5	CALLV #5	BZ rel
E	MOV A,R6	CMP A,R6	ADDC A,R6	SUBC A,R6	XOR A,R6	MOV R6,A	XOR A,R6	AND A,R6	OR A,R6	MOV R6,#d8	CMP R6,#d8	SETB dir: 6	BBS dir: 6,rel	INC R6	DEC R6	CALLV #6	BGE rel
F	MOV A,R7	CMP A,R7	ADDC A,R7	SUBC A,R7	XOR A,R7	MOV R7,A	XOR A,R7	AND A,R7	OR A,R7	MOV R7,#d8	CMP R7,#d8	SETB dir: 7	BBS dir: 7,rel	INC R7	DEC R7	CALLV #7	BLT rel

# MB89580B/580BW series

## ■ ORDERING INFORMATION

Part number	Package	Remarks
MB89589BPFM MB89P589BPFM	64-pin plastic QFP (FPT-64P-M09)	
MB89583BPFV MB89585BPFV MB89P585BPFV MB89583BWPFV MB89585BWPFV MB89P585BWPFV	64-pin plastic LQFP (FPT-64P-M03)	



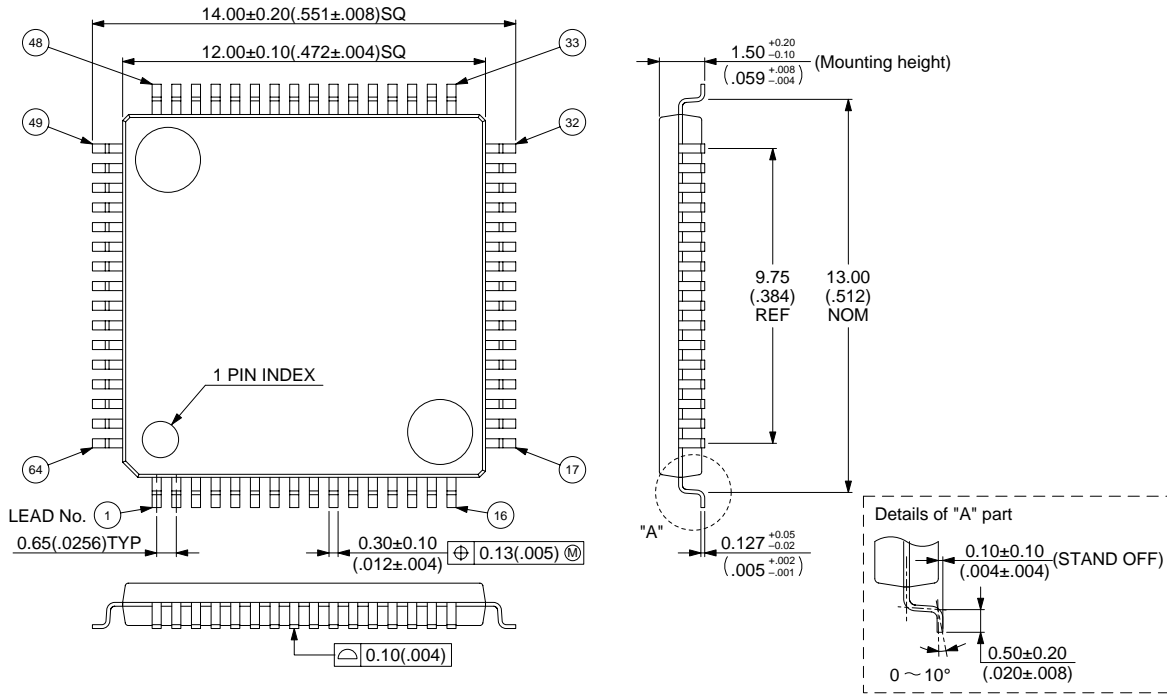


# MB89580B/580BW series

(Continued)

64-pin plastic QFP  
(FPT-64P-M09)

Note: Pins width and pins thickness include plating thickness.



© 2000 FUJITSU LIMITED F64018S-1C-3

Dimensions in mm (inches)

# MB89580B/580BW series

## FUJITSU LIMITED

*For further information please contact:*

### Japan

FUJITSU LIMITED  
Corporate Global Business Support Division  
Electronic Devices  
Shinjuku Dai-Ichi Seimei Bldg. 7-1,  
Nishishinjuku 2-chome, Shinjuku-ku,  
Tokyo 163-0721, Japan  
Tel: +81-3-5322-3347  
Fax: +81-3-5322-3386

<http://www.fujitsu.co.jp/>

### North and South America

FUJITSU MICROELECTRONICS, INC.  
3545 North First Street,  
San Jose, CA 95134-1804, U.S.A.  
Tel: +1-408-922-9000  
Fax: +1-408-922-9179

Customer Response Center  
*Mon. - Fri.: 7 am - 5 pm (PST)*  
Tel: +1-800-866-8608  
Fax: +1-408-922-9179

<http://www.fujitsumicro.com/>

### Europe

FUJITSU MICROELECTRONICS EUROPE GmbH  
Am Siebenstein 6-10,  
D-63303 Dreieich-Buchsschlag,  
Germany  
Tel: +49-6103-690-0  
Fax: +49-6103-690-122

<http://www.fujitsu-fme.com/>

### Asia Pacific

FUJITSU MICROELECTRONICS ASIA PTE. LTD.  
#05-08, 151 Lorong Chuan,  
New Tech Park,  
Singapore 556741  
Tel: +65-281-0770  
Fax: +65-281-0220

<http://www.fmap.com.sg/>

### Korea

FUJITSU MICROELECTRONICS KOREA LTD.  
1702 KOSMO TOWER, 1002 Daechi-Dong,  
Kangnam-Gu, Seoul 135-280  
Korea  
Tel: +82-2-3484-7100  
Fax: +82-2-3484-7111

F0012

© FUJITSU LIMITED Printed in Japan

All Rights Reserved.

The contents of this document are subject to change without notice. Customers are advised to consult with FUJITSU sales representatives before ordering.

The information and circuit diagrams in this document are presented as examples of semiconductor device applications, and are not intended to be incorporated in devices for actual use. Also, FUJITSU is unable to assume responsibility for infringement of any patent rights or other rights of third parties arising from the use of this information or circuit diagrams.

The contents of this document may not be reproduced or copied without the permission of FUJITSU LIMITED.

FUJITSU semiconductor devices are intended for use in standard applications (computers, office automation and other office equipments, industrial, communications, and measurement equipments, personal or household devices, etc.).

#### CAUTION:

Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, sea floor repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with FUJITSU sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

Any semiconductor devices have inherently a certain rate of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

If any products described in this document represent goods or technologies subject to certain restrictions on export under the Foreign Exchange and Foreign Trade Control Law of Japan, the prior authorization by Japanese government should be required for export of those products from Japan.